IS42S32200L
IS45S32200L

512K Bits x 32 Bits x 4 Banks (64-MBIT) SYNCHRONOUS DYNAMIC RAM

OCTOBER 2019

FEATURES

- Clock frequency: 200, 166, 143, 133 MHz
- Fully synchronous; all signals referenced to a positive clock edge
- Internal bank for hiding row access/precharge
- Single 3.3V power supply
- LVTTL interface
- Programmable burst length: (1, 2, 4, 8, full page)
- Programmable burst sequence: Sequential/Interleave
- Self refresh modes
- 4096 refresh cycles every 16ms (A2 grade) or 64ms (Commercia, Industrial, A1 grade)
- Random column address every clock cycle
- Programmable $\overline{\text{CAS}}$ latency (2, 3 clocks)
- Burst read/write and burst read/single write operations capability
- Burst termination by burst stop and precharge command

OPTIONS

- Packages:
  86-pin TSOP-II
  90-ball TF-BGA
- Operating temperature range:
  Commercial (0°C to + 70°C)
  Industrial (-40°C to + 85°C)
  Automotive Grade, A1 (-40°C to + 85°C)
  Automotive Grade, A2: (-40°C to +105°C)

OVERVIEW

ISSI's 64Mb Synchronous DRAM IS42/45S32200L is organized as 524,288 bits x 32-bit x 4-bank for improved performance. The synchronous DRAMs achieve high-speed data transfer using pipeline architecture. All inputs and outputs signals refer to the rising edge of the clock input.

KEY TIMING PARAMETERS

Parameter	-5	-6	-7	Unit
Clk Cycle Time				
$\overline{\text{CAS}}$ Latency = 3	5	6	7	ns
$\overline{\text{CAS}}$ Latency = 2	7.5	7.5	7.5	ns
Clk Frequency				
$\overline{\text{CAS}}$ Latency = 3	200	166	143	Mhz
$\overline{\text{CAS}}$ Latency = 2	133	133	133	Mhz
Access Time from Clock				
$\overline{\text{CAS}}$ Latency = 3	4.8	5.4	5.4	ns
$\overline{\text{CAS}}$ Latency = 2	5.4	5.4	5.4	ns

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a.) the risk of injury or damage has been minimized;
b.) the user assume all such risks; and
c.) potential liability of Integrated Silicon Solution, Inc is adequately protected under the circumstances

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GENERAL DESCRIPTION

The 64Mb SDRAM is a high speed CMOS, dynamic random-access memory designed to operate in 3.3V memory systems containing 67,108,864 bits. Internally configured as a quad-bank DRAM with a synchronous interface. Each 16,777,216-bit bank is organized as 2,048 rows by 256 columns by 32 bits.

The 64Mb SDRAM includes an AUTO REFRESH MODE, and a power-saving, power-down mode. All signals are registered on the positive edge of the clock signal, CLK. All inputs and outputs are LVTTL compatible.

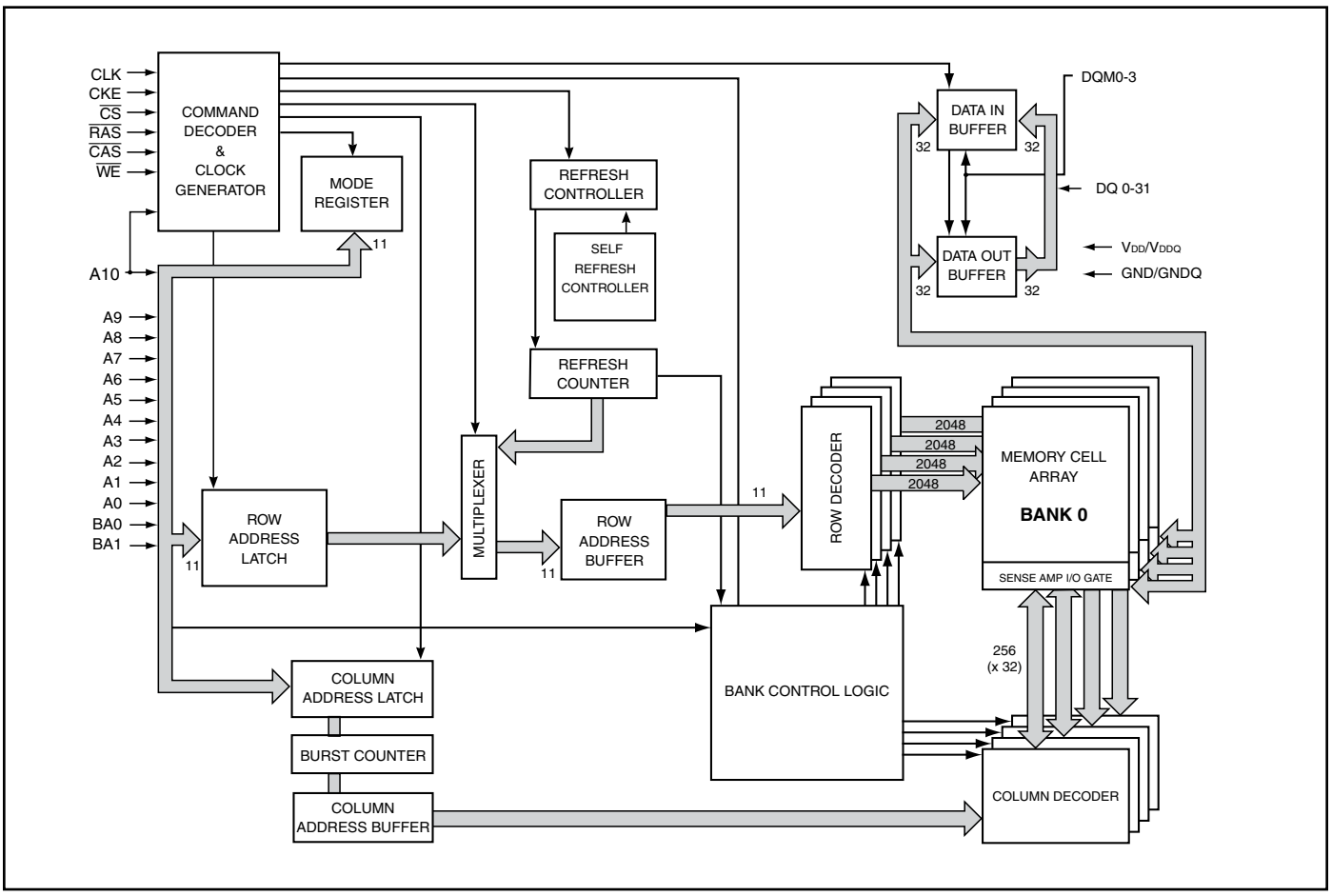
The 64Mb SDRAM has the ability to synchronously burst data at a high data rate with automatic column-address generation, the ability to interleave between internal banks to hide precharge time and the capability to randomly change column addresses on each clock cycle during burst access.

A self-timed row precharge initiated at the end of the burst sequence is available with the AUTO PRECHARGE function enabled. Precharge one bank while accessing one of the other three banks will hide the precharge cycles and provide seamless, high-speed, random-access operation.

SDRAM read and write accesses are burst oriented starting at a selected location and continuing for a programmed number of locations in a programmed sequence. The registration of an ACTIVE command begins accesses, followed by a READ or WRITE command. The ACTIVE command in conjunction with address bits registered are used to select the bank and row to be accessed (BA0, BA1 select the bank; A0-A10 select the row). The READ or WRITE commands in conjunction with address bits registered are used to select the starting column location for the burst access.

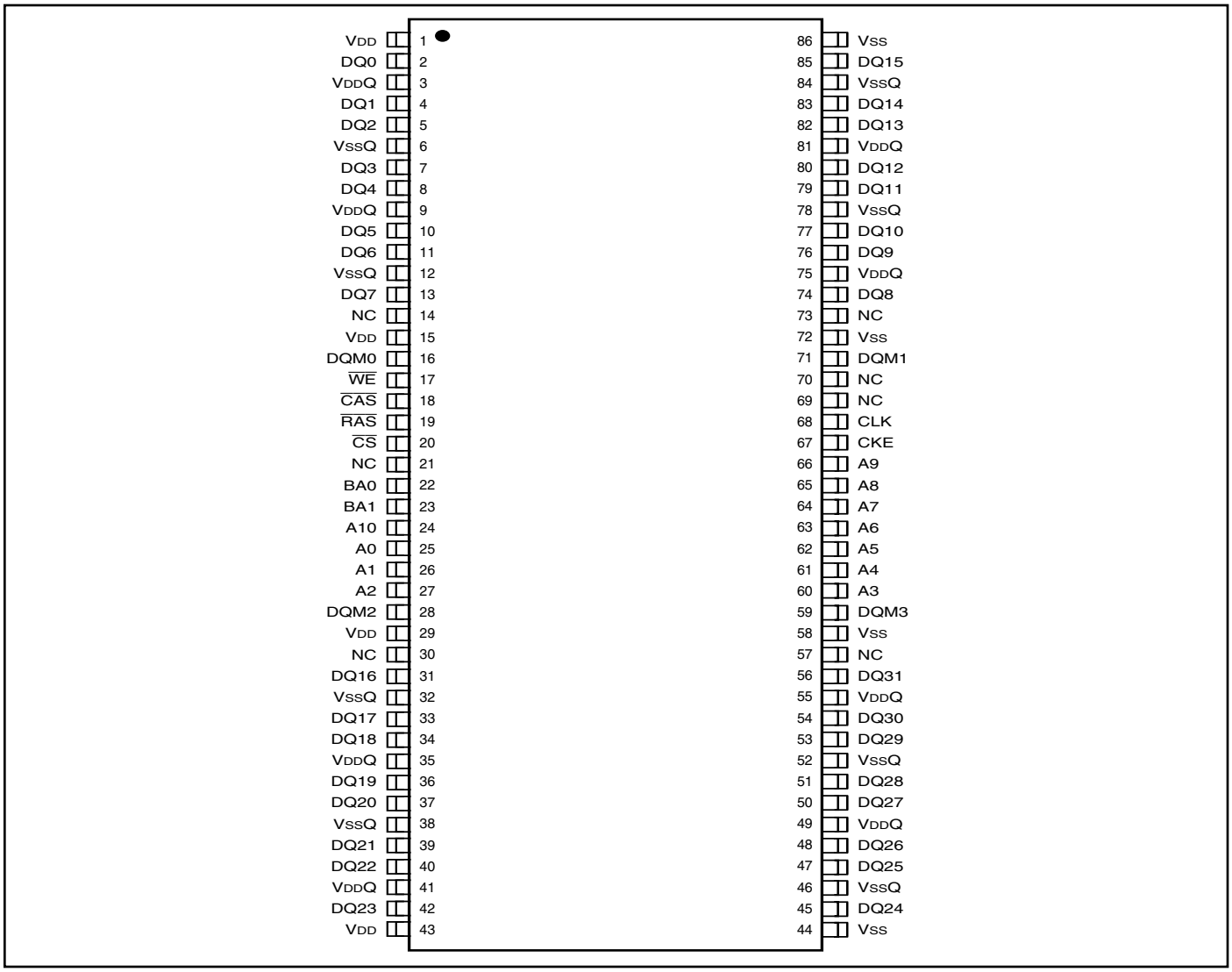
Programmable READ or WRITE burst lengths consist of 1, 2, 4 and 8 locations or full page, with a burst terminate option.

FUNCTIONAL BLOCK DIAGRAM



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PIN CONFIGURATIONS
86 pin TSOP - Type II for x32



PIN DESCRIPTIONS

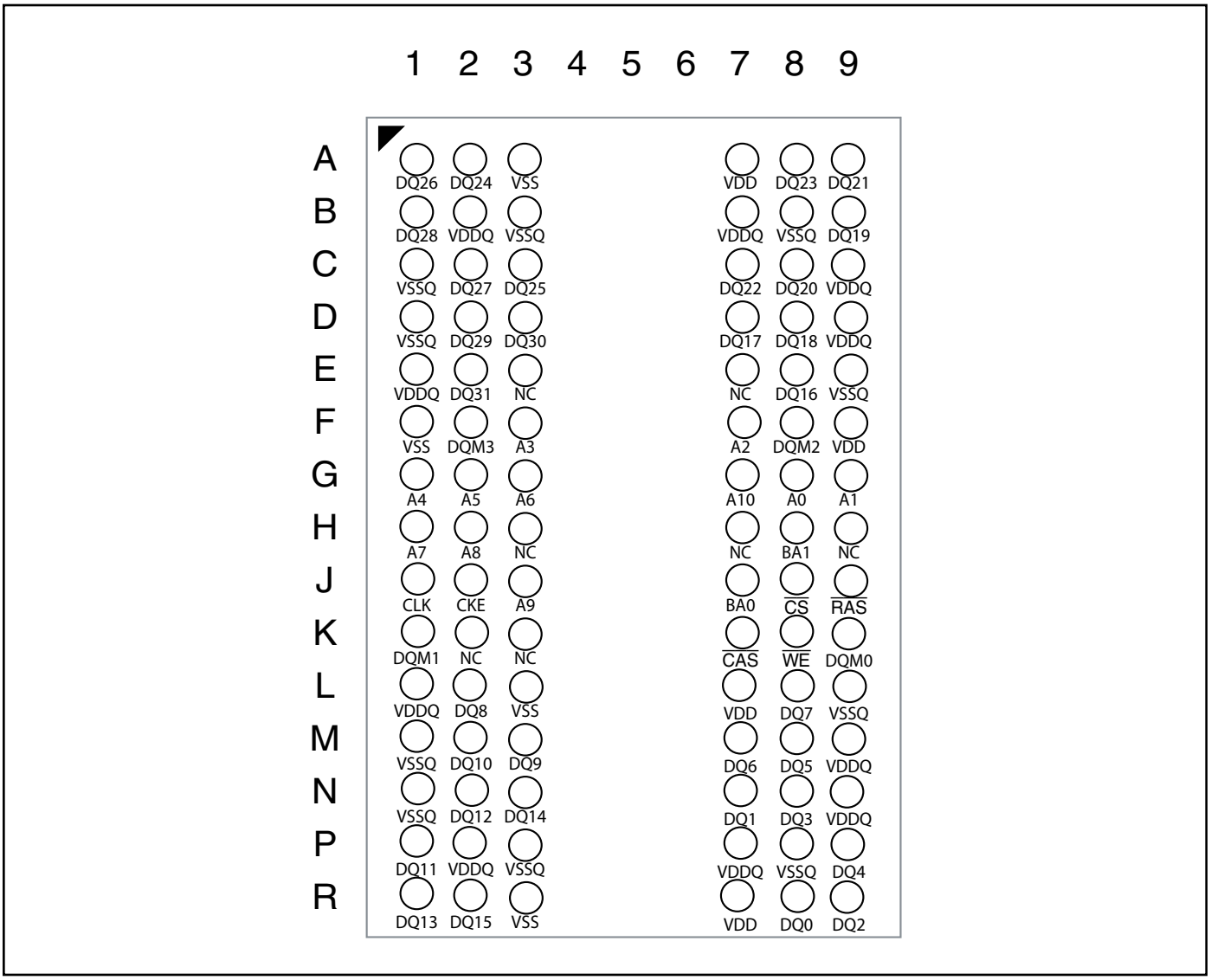
A0-A10	Row Address Input
A0-A7	Column Address Input
BA0, BA1	Bank Select Address
DQ0 to DQ31	Data I/O
CLK	System Clock Input
CKE	Clock Enable
$\overline{CS}$	Chip Select
$\overline{RAS}$	Row Address Strobe Command
$\overline{CAS}$	Column Address Strobe Command

$\overline{WE}$	Write Enable
DQM0-DQM3	x32 Input/Output Mask
V_{DD}	Power
Vss	Ground
V_{DDQ}	Power Supply for I/O Pin
V_{SSQ}	Ground for I/O Pin
NC	No Connection

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PIN CONFIGURATION

PACKAGE CODE: B 90 BALL TF-BGA (Top View) (8.00 mm x 13.00 mm Body, 0.8 mm Ball Pitch)



PIN DESCRIPTIONS

A0-A10	Row Address Input
A0-A7	Column Address Input
BA0, BA1	Bank Select Address
DQ0 to DQ31	Data I/O
CLK	System Clock Input
CKE	Clock Enable
$\overline{CS}$	Chip Select
$\overline{RAS}$	Row Address Strobe Command
$\overline{CAS}$	Column Address Strobe Command

$\overline{WE}$	Write Enable
DQM0-DQM3	x32 Input/Output Mask
V_{DD}	Power
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V_{DDQ}	Power Supply for I/O Pin
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PIN FUNCTIONS

Symbol	Pin No. (TSOP)	Type	Function (In Detail)
A0-A10	25 to 27 60 to 66 24	Input Pin	Address Inputs: A0-A10 are sampled during the ACTIVE command (row-address A0-A10) and READ/WRITE command (A0-A7 with A10 defining auto precharge) to select one location out of the memory array in the respective bank. A10 is sampled during a PRECHARGE command to determine if all banks are to be precharged (A10 HIGH) or bank selected by BA0, BA1 (LOW). The address inputs also provide the op-code during a LOAD MODE REGISTER command.
BA0, BA1	22,23	Input Pin	Bank Select Address: BA0 and BA1 defines which bank the ACTIVE, READ, WRITE or PRECHARGE command is being applied.
$\overline{CAS}$	18	Input Pin	$\overline{CAS}$, in conjunction with the $\overline{RAS}$ and $\overline{WE}$, forms the device command. See the "Command Truth Table" for details on device commands.
CKE	67	Input Pin	The CKE input determines whether the CLK input is enabled. The next rising edge of the CLK signal will be valid when is CKE HIGH and invalid when LOW. When CKE is LOW, the device will be in either power-down mode, clock suspend mode, or self refresh mode. CKE is an asynchronous input.
CLK	68	Input Pin	CLK is the master clock input for this device. Except for CKE, all inputs to this device are acquired in synchronization with the rising edge of this pin.
$\overline{CS}$	20	Input Pin	The $\overline{CS}$ input determines whether command input is enabled within the device. Command input is enabled when $\overline{CS}$ is LOW, and disabled with $\overline{CS}$ is HIGH. The device remains in the previous state when $\overline{CS}$ is HIGH.
DQ0 to DQ31	2, 4, 5, 7, 8, 10,11,13 74,76,77,79,80,82,83,85 45,47,48,50,51,53,54,56 31,33,34,36,37,39,40,42	DQ Pin	DQ0 to DQ15 are DQ pins. DQ through these pins can be controlled in byte units using the DQM0-DQM3 pins
DQM0 DQM3	16,28,59,71	Input Pin	DQMx control thel ower and upper bytes of the DQ buffers. In read mode, the output buffers are place in a High-Z state. During a WRITE cycle the input data is masked. When DQMx is sampled HIGH and is an input mask signal for write accesses and an output enable signal for read accesses. DQ0 through DQ7 are controlled by DQM0. DQ8 throughDQ15 are controlled by DQM1. DQ16 through DQ23 are controlled by DQM2. DQ24 through DQ31 are controlled by DQM3.
$\overline{RAS}$	19	Input Pin	$\overline{RAS}$, in conjunction with $\overline{CAS}$ and $\overline{WE}$, forms the device command. See the "Command Truth Table" item for details on device commands.
$\overline{WE}$	17	Input Pin	$\overline{WE}$, in conjunction with $\overline{RAS}$ and $\overline{CAS}$, forms the device command. See the "Command Truth Table" item for details on device commands.
V_{DDQ}	3,9,35,41,49,55,75,81	Supply Pin	V_{DDQ} is the output buffer power supply.
V_{DD}	1,15,29,43	Supply Pin	V_{DD} is the device internal power supply.
GND_Q	6,12,32,38,46,52,78,84	Supply Pin	GND_Q is the output buffer ground.
GND	44,58,72,86	Supply Pin	GND is the device internal ground.

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READ

The READ command selects the bank from BA0, BA1 inputs and starts a burst read access to an active row. Inputs A0-A7 provides the starting column location. When A10 is HIGH, this command functions as an AUTO PRECHARGE command. When the auto precharge is selected, the row being accessed will be precharged at the end of the READ burst. The row will remain open for subsequent accesses when AUTO PRECHARGE is not selected. DQ's read data is subject to the logic level on the DQM inputs two clocks earlier. When a given DQM signal was registered HIGH, the corresponding DQ's will be High-Z two clocks later. DQ's will provide valid data when the DQM signal was registered LOW.

WRITE

A burst write access to an active row is initiated with the WRITE command. BA0, BA1 inputs selects the bank, and the starting column location is provided by inputs A0-A7. Whether or not AUTO-PRECHARGE is used is determined by A10.

The row being accessed will be precharged at the end of the WRITE burst, if AUTO PRECHARGE is selected. If AUTO PRECHARGE is not selected, the row will remain open for subsequent accesses.

A memory array is written with corresponding input data on DQ's and DQM input logic level appearing at the same time. Data will be written to memory when DQM signal is LOW. When DQM is HIGH, the corresponding data inputs will be ignored, and a WRITE will not be executed to that byte/column location.

PRECHARGE

The PRECHARGE command is used to deactivate the open row in a particular bank or the open row in all banks. BA0, BA1 can be used to select which bank is precharged or they are treated as "Don't Care". A10 determined whether one or all banks are precharged. After executing this command, the next command for the selected banks(s) is executed after passage of the period t_{RP}, which is the period required for bank precharging. Once a bank has been precharged, it is in the idle state and must be activated prior to any READ or WRITE commands being issued to that bank.

AUTO PRECHARGE

The AUTO PRECHARGE function ensures that the precharge is initiated at the earliest valid stage within a burst. This function allows for individual-bank precharge without requiring an explicit command. A10 to enables the AUTO PRECHARGE function in conjunction with a specific READ or WRITE command. For each individual READ or WRITE command, auto precharge is either enabled or disabled. AUTO PRECHARGE does not apply except in full-page burst mode. Upon completion of the READ or WRITE burst, a precharge of the bank/row that is addressed is automatically performed.

AUTO REFRESH COMMAND

This command executes the AUTO REFRESH operation. The row address and bank to be refreshed are automatically generated during this operation. The stipulated period (t_{RC}) is required for a single refresh operation, and no other commands can be executed during this period. This command is executed at least 4096 times every t_{REF}. During an AUTO REFRESH command, address bits are "Don't Care". This command corresponds to CBR Auto-refresh.

SELF REFRESH

During the SELF REFRESH operation, the row address to be refreshed, the bank, and the refresh interval are generated automatically internally. SELF REFRESH can be used to retain data in the SDRAM without external clocking, even if the rest of the system is powered down. The SELF REFRESH operation is started by dropping the CKE pin from HIGH to LOW. During the SELF REFRESH operation all other inputs to the SDRAM become "Don't Care".The device must remain in self refresh mode for a minimum period equal to t_{RAS} or may remain in self refresh mode for an indefinite period beyond that.The SELF-REFRESH operation continues as long as the CKE pin remains LOW and there is no need for external control of any other pins. The next command cannot be executed until the device internal recovery period (t_{RC}) has elapsed. Once CKE goes HIGH, the NOP command must be issued (minimum of two clocks) to provide time for the completion of any internal refresh in progress. After the self-refresh, since it is impossible to determine the address of the last row to be refreshed, an AUTO-REFRESH should immediately be performed for all addresses.

BURST TERMINATE

The BURST TERMINATE command forcibly terminates the burst read and write operations by truncating either fixed-length or full-page bursts and the most recently registered READ or WRITE command prior to the BURST TERMINATE.

COMMAND INHIBIT

COMMAND INHIBIT prevents new commands from being executed. Operations in progress are not affected, apart from whether the CLK signal is enabled

NO OPERATION

When $\overline{CS}$ is low, the NOP command prevents unwanted commands from being registered during idle or wait states.

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LOAD MODE REGISTER

During the LOAD MODE REGSITER command the mode register is loaded from A0-A10. This command can only be issued when all banks are idle.

ACTIVE COMMAND

When the ACTIVE COMMAND is activated, BA0, BA1 inputs selects a bank to be accessed, and the address inputs on A0-A10 selects the row. Until a PRECHARGE command is issued to the bank, the row remains open for accesses.

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TRUTH TABLE – COMMANDS AND DQM OPERATION(1)

FUNCTION	$\overline{CS}$	$\overline{RAS}$	$\overline{CAS}$	$\overline{WE}$	DQM	ADDR	DQs
COMMAND INHIBIT (NOP)	H	X	X	X	X	X	X
NO OPERATION (NOP)	L	H	H	H	X	X	X
ACTIVE (Select bank and activate row)(3)	L	L	H	H	X	Bank/Row	X
READ (Select bank/column, start READ burst)(4)	L	H	L	H	L/H(8)	Bank/Col	X
WRITE (Select bank/column, start WRITE burst)(4)	L	H	L	L	L/H(8)	Bank/Col	Valid
BURST TERMINATE	L	H	H	L	X	X	Active
PRECHARGE (Deactivate row in bank or banks)(5)	L	L	H	L	X	Code	X
AUTO REFRESH or SELF REFRESH(6,7) (Enter self refresh mode)	L	L	L	H	X	X	X
LOAD MODE REGISTER(2)	L	L	L	L	X	Op-Code	X
Write Enable/Output Enable(8)	—	—	—	—	L	—	Active
Write Inhibit/Output High-Z(8)	—	—	—	—	H	—	High-Z

NOTES:
1. CKE is HIGH for all commands except SELF REFRESH.
2. A0-A10 define the op-code written to the mode register.
3. A0-A10 provide row address, and BA0, BA1 determine which bank is made active.
4. A0-A7 (x32) provide column address; A10 HIGH enables the auto precharge feature (nonpersistent), while A10 LOW disables auto precharge; BA0, BA1 determine which bank is being read from or written to.
5. A10 LOW: BA0, BA1 determine the bank being precharged. A10 HIGH: All banks precharged and BA0, BA1 are “Don’t Care.”
6. AUTO REFRESH if CKE is HIGH, SELF REFRESH if CKE is LOW.
7. Internal refresh counter controls row addressing; all inputs and DQs are “Don’t Care” except for CKE.
8. Activates or deactivates the DQs during WRITEs (zero-clock delay) and READs (two-clock delay).

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TRUTH TABLE – CKE (1-4)

CURRENT STATE	COMMANDn	ACTIONn	CKEn-1	CKEn
Power-Down	X	Maintain Power-Down	L	L
Self Refresh	X	Maintain Self Refresh	L	L
Clock Suspend	X	Maintain Clock Suspend	L	L
Power-Down(5)	COMMAND INHIBIT or NOP	Exit Power-Down	L	H
Self Refresh(6)	COMMAND INHIBIT or NOP	Exit Self Refresh	L	H
Clock Suspend(7)	X	Exit Clock Suspend	L	H
All Banks Idle	COMMAND INHIBIT or NOP	Power-Down Entry	H	L
All Banks Idle	AUTO REFRESH	Self Refresh Entry	H	L
Reading or Writing	VALID	Clock Suspend Entry	H	L
	See TRUTH TABLE – CURRENT STATE BANK n, COMMAND TO BANK *n*		H	H

NOTES:
1. CKEn is the logic state of CKE at clock edge *n*; CKEn-1 was the state of CKE at the previous clock edge.
2. Current state is the state of the SDRAM immediately prior to clock edge *n*.
3. COMMANDn is the command registered at clock edge *n*, and ACTONn is a result of COMMANDn.
4. All states and sequences not shown are illegal or reserved.
5. Exiting power-down at clock edge *n* will put the device in the all banks idle state in time for clock edge *n+1* (provided that t_{CKS} is met).
6. Exiting self refresh at clock edge *n* will put the device in all banks idle state once t_{XSR} is met. COMMAND INHIBIT or NOP commands should be issued on clock edges occurring during the t_{XSR} period. A minimum of two NOP commands must be sent during t_{XSR} period.
7. After exiting clock suspend at clock edge *n*, the device will resume operation and recognize the next command at clock edge *n+1*.

TRUTH TABLE – CURRENT STATE BANK n, COMMAND TO BANK *n* (1-6)

CURRENT STATE	COMMAND (ACTION)	$\overline{CS}$	$\overline{RAS}$	$\overline{CAS}$	$\overline{WE}$
Any	COMMAND INHIBIT (NOP/Continue previous operation)	H	X	X	X
	NO OPERATION (NOP/Continue previous operation)	L	H	H	H
Idle	ACTIVE (Select and activate row)	L	L	H	H
	AUTO REFRESH(7)	L	L	L	H
	LOAD MODE REGISTER(7)	L	L	L	L
	PRECHARGE(11)	L	L	H	L
Row Active	READ (Select column and start READ burst)(10)	L	H	L	H
	WRITE (Select column and start WRITE burst)(10)	L	H	L	L
	PRECHARGE (Deactivate row in bank or banks)(8)	L	L	H	L
Read (Auto Precharge Disabled)	READ (Select column and start new READ burst)(10)	L	H	L	H
	WRITE (Select column and start WRITE burst)(10)	L	H	L	L
	PRECHARGE (Truncate READ burst, start PRECHARGE)(8)	L	L	H	L
	BURST TERMINATE(9)	L	H	H	L
Write (Auto Precharge Disabled)	READ (Select column and start READ burst)(10)	L	H	L	H
	WRITE (Select column and start new WRITE burst)(10)	L	H	L	L
	PRECHARGE (Truncate WRITE burst, start PRECHARGE)(8)	L	L	H	L
	BURST TERMINATE(9)	L	H	H	L

NOTE:
1. This table applies when CKE n-1 was HIGH and CKE n is HIGH (see Truth Table - CKE) and after t_{XSR} has been met (if the previous state was SELF REFRESH).
2. This table is bank-specific, except where noted; i.e., the current state is for a specific bank and the commands shown are those allowed to be issued to that bank when in that state. Exceptions are covered in the notes below.

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3. Current state definitions:
   - Idle: The bank has been precharged, and t_{RP} has been met.
   - Row Active: A row in the bank has been activated, and t_{RCD} has been met. No data bursts/accesses and no register accesses are in progress.
   - Read: A READ burst has been initiated, with auto precharge disabled, and has not yet terminated or been terminated.
   - Write: A WRITE burst has been initiated, with auto precharge disabled, and has not yet terminated or been terminated.
4. The following states must not be interrupted by a command issued to the same bank. COMMAND INHIBIT or NOP commands, or allowable commands to the other bank should be issued on any clock edge occurring during these states. Allowable commands to the other bank are determined by its current state and CURRENT STATE BANK n truth tables.
   - Precharging: Starts with registration of a PRECHARGE command and ends when t_{RP} is met. Once t_{RP} is met, the bank will be in the idle state.
   - Row Activating: Starts with registration of an ACTIVE command and ends when t_{RCD} is met. Once t_{RCD} is met, the bank will be in the row active state.
   - Read w/Auto Precharge Enabled: Starts with registration of a READ command with auto precharge enabled and ends when t_{RP} has been met. Once t_{RP} is met, the bank will be in the idle state.
   - Write w/Auto Precharge Enabled: Starts with registration of a WRITE command with auto precharge enabled and ends when t_{RP} has been met. Once t_{RP} is met, the bank will be in the idle state.
5. The following states must not be interrupted by any executable command; COMMAND INHIBIT or NOP commands must be applied on each positive clock edge during these states.
   - Refreshing: Starts with registration of an AUTO REFRESH command and ends when t_{RC} is met. Once t_{RC} is met, the SDRAM will be in the all banks idle state.
   - Accessing Mode Register: Starts with registration of a LOAD MODE REGISTER command and ends when t_{MRD} has been met. Once t_{MRD} is met, the SDRAM will be in the all banks idle state.
   - Precharging All: Starts with registration of a PRECHARGE ALL command and ends when t_{RP} is met. Once t_{RP} is met, all banks will be in the idle state.
6. All states and sequences not shown are illegal or reserved.
7. Not bank-specific; requires that all banks are idle.
8. May or may not be bank-specific; if all banks are to be precharged, all must be in a valid state for precharging.
9. Not bank-specific; BURST TERMINATE affects the most recent READ or WRITE burst, regardless of bank.
10. READs or WRITEs listed in the Command (Action) column include READs or WRITEs with auto precharge enabled and READs or WRITEs with auto precharge disabled.
11. Does not affect the state of the bank and acts as a NOP to that bank.

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TRUTH TABLE – CURRENT STATE BANK *n*, COMMAND TO BANK *m* (1-6)

CURRENT STATE	COMMAND (ACTION)	$\overline{CS}$	$\overline{RAS}$	$\overline{CAS}$	$\overline{WE}$
Any	COMMAND INHIBIT (NOP/Continue previous operation)	H	X	X	X
	NO OPERATION (NOP/Continue previous operation)	L	H	H	H
Idle	Any Command Otherwise Allowed to Bank *m*	X	X	X	X
Row Activating, Active, or Precharging	ACTIVE (Select and activate row)	L	L	H	H
	READ (Select column and start READ burst)(7)	L	H	L	H
	WRITE (Select column and start WRITE burst)(7)	L	H	L	L
	PRECHARGE	L	L	H	L
Read (Auto Precharge Disabled)	ACTIVE (Select and activate row)	L	L	H	H
	READ (Select column and start new READ burst)(7,10)	L	H	L	H
	WRITE (Select column and start WRITE burst)(7,11)	L	H	L	L
	PRECHARGE(9)	L	L	H	L
Write (Auto Precharge Disabled)	ACTIVE (Select and activate row)	L	L	H	H
	READ (Select column and start READ burst)(7,12)	L	H	L	H
	WRITE (Select column and start new WRITE burst)(7,13)	L	H	L	L
	PRECHARGE(9)	L	L	H	L
Read (With Auto Precharge)	ACTIVE (Select and activate row)	L	L	H	H
	READ (Select column and start new READ burst)(7,8,14)	L	H	L	H
	WRITE (Select column and start WRITE burst)(7,8,15)	L	H	L	L
	PRECHARGE(9)	L	L	H	L
Write (With Auto Precharge)	ACTIVE (Select and activate row)	L	L	H	H
	READ (Select column and start READ burst)(7,8,16)	L	H	L	H
	WRITE (Select column and start new WRITE burst)(7,8,17)	L	H	L	L
	PRECHARGE(9)	L	L	H	L

NOTE:

1. This table applies when CKE n-1 was HIGH and CKE n is HIGH (Truth Table - CKE) and after t_{XSR} has been met (if the previous state was self refresh).
2. This table describes alternate bank operation, except where noted; i.e., the current state is for bank *n* and the commands shown are those allowed to be issued to bank *m* (assuming that bank *m* is in such a state that the given command is allowable). Exceptions are covered in the notes below.
3. Current state definitions:
   - Idle: The bank has been precharged, and t_{RP} has been met.
   - Row Active: A row in the bank has been activated, and t_{RCD} has been met. No data bursts/accesses and no register accesses are in progress.
   - Read: A READ burst has been initiated, with auto precharge disabled, and has not yet terminated or been terminated.
   - Write: A WRITE burst has been initiated, with auto precharge disabled, and has not yet terminated or been terminated.
   - Read w/Auto Precharge Enabled: Starts with registration of a READ command with auto precharge enabled, and ends when t_{RP} has been met. Once t_{RP} is met, the bank will be in the idle state.
   - Write w/Auto Precharge Enabled: Starts with registration of a WRITE command with auto precharge enabled, and ends when t_{RP} has been met. Once t_{RP} is met, the bank will be in the idle state.
4. AUTO REFRESH, SELF REFRESH and LOAD MODE REGISTER commands may only be issued when all banks are idle.
5. A BURST TERMINATE command cannot be issued to another bank; it applies to the bank represented by the current state only.
6. All states and sequences not shown are illegal or reserved.
7. READs or WRITEs to bank m listed in the Command (Action) column include READs or WRITEs with auto precharge enabled and READs or WRITEs with auto precharge disabled.

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8. CONCURRENT AUTO PRECHARGE: Bank n will initiate the AUTO PRECHARGE command when its burst has been interrupted by bank m's burst.
9. Burst in bank n continues as initiated.
10. For a READ without auto precharge interrupted by a READ (with or without auto precharge), the READ to bank m will interrupt the READ on bank n, CAS latency later (Consecutive READ Bursts).
11. For a READ without auto precharge interrupted by a WRITE (with or without auto precharge), the WRITE to bank m will interrupt the READ on bank n when registered (READ to WRITE). DQM should be used one clock prior to the WRITE command to prevent bus contention.
12. For a WRITE without auto precharge interrupted by a READ (with or without auto precharge), the READ to bank m will interrupt the WRITE on bank n when registered (WRITE to READ), with the data-out appearing CAS latency later. The last valid WRITE to bank n will be data-in registered one clock prior to the READ to bank m.
13. For a WRITE without auto precharge interrupted by a WRITE (with or without auto precharge), the WRITE to bank m will interrupt the WRITE on bank n when registered (WRITE to WRITE). The last valid WRITE to bank n will be data-in registered one clock prior to the READ to bank m.
14. For a READ with auto precharge interrupted by a READ (with or without auto precharge), the READ to bank m will interrupt the READ on bank n, CAS latency later. The PRECHARGE to bank n will begin when the READ to bank m is registered (Fig CAP 1).
15. For a READ with auto precharge interrupted by a WRITE (with or without auto precharge), the WRITE to bank m will interrupt the READ on bank n when registered. DQM should be used two clocks prior to the WRITE command to prevent bus contention. The PRECHARGE to bank n will begin when the WRITE to bank m is registered (Fig CAP 2).
16. For a WRITE with auto precharge interrupted by a READ (with or without auto precharge), the READ to bank m will interrupt the WRITE on bank n when registered, with the data-out appearing CAS latency later. The PRECHARGE to bank n will begin after t_{WR} is met, where t_{WR} begins when the READ to bank m is registered. The last valid WRITE to bank n will be data-in registered one clock prior to the READ to bank m (Fig CAP 3).
17. For a WRITE with auto precharge interrupted by a WRITE (with or without auto precharge), the WRITE to bank m will interrupt the WRITE on bank n when registered. The PRECHARGE to bank n will begin after t_{WR} is met, where t WR begins when the WRITE to bank m is registered. The last valid WRITE to bank n will be data registered one clock prior to the WRITE to bank m (Fig CAP 4).

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FUNCTIONAL DESCRIPTION

The 64Mb SDRAMs 512K x 32 x 4 banks) are quad-bank DRAMs which operate at 3.3V and include a synchronous interface (all signals are registered on the positive edge of the clock signal, CLK). Each of the 16,777,216-bit banks is organized as 2,048 rows by 256 columns by 32bits.

Read and write accesses to the SDRAM are burst oriented; accesses start at a selected location and continue for a programmed number of locations in a programmed sequence. Accesses begin with the registration of an ACTIVE command which is then followed by a READ or WRITE command. The address bits registered coincident with the ACTIVE command are used to select the bank and row to be accessed (BA0 and BA1 select the bank, A0-A10 select the row). The address bits (A0-A7) registered coincident with the READ or WRITE command are used to select the starting column location for the burst access.

Prior to normal operation, the SDRAM must be initialized. The following sections provide detailed information covering device initialization, register definition, command descriptions and device operation.

Initialization

SDRAMs must be powered up and initialized in a predefined manner.

The 64M SDRAM is initialized after the power is applied to V_{DD} and V_{DDQ} (simultaneously) and the clock is stable.

A 100µs delay is required prior to issuing any command other than a COMMAND INHIBIT or a NOP. The COMMAND INHIBIT or NOP may be applied during the 100us period and continue should at least through the end of the period.

With at least one COMMAND INHIBIT or NOP command having been applied, a PRECHARGE command should be applied once the 100µs delay has been satisfied. All banks must be precharged. This will leave all banks in an idle idle state where two AUTO REFRESH cycles must be performed. After the AUTO REFRESH cycles are complete, the SRDRAM is then ready for mode register programming.

The mode register should be loaded prior to applying any operational command because it will power up in an unknown state.

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REGISTER DEFINITION

Mode Register

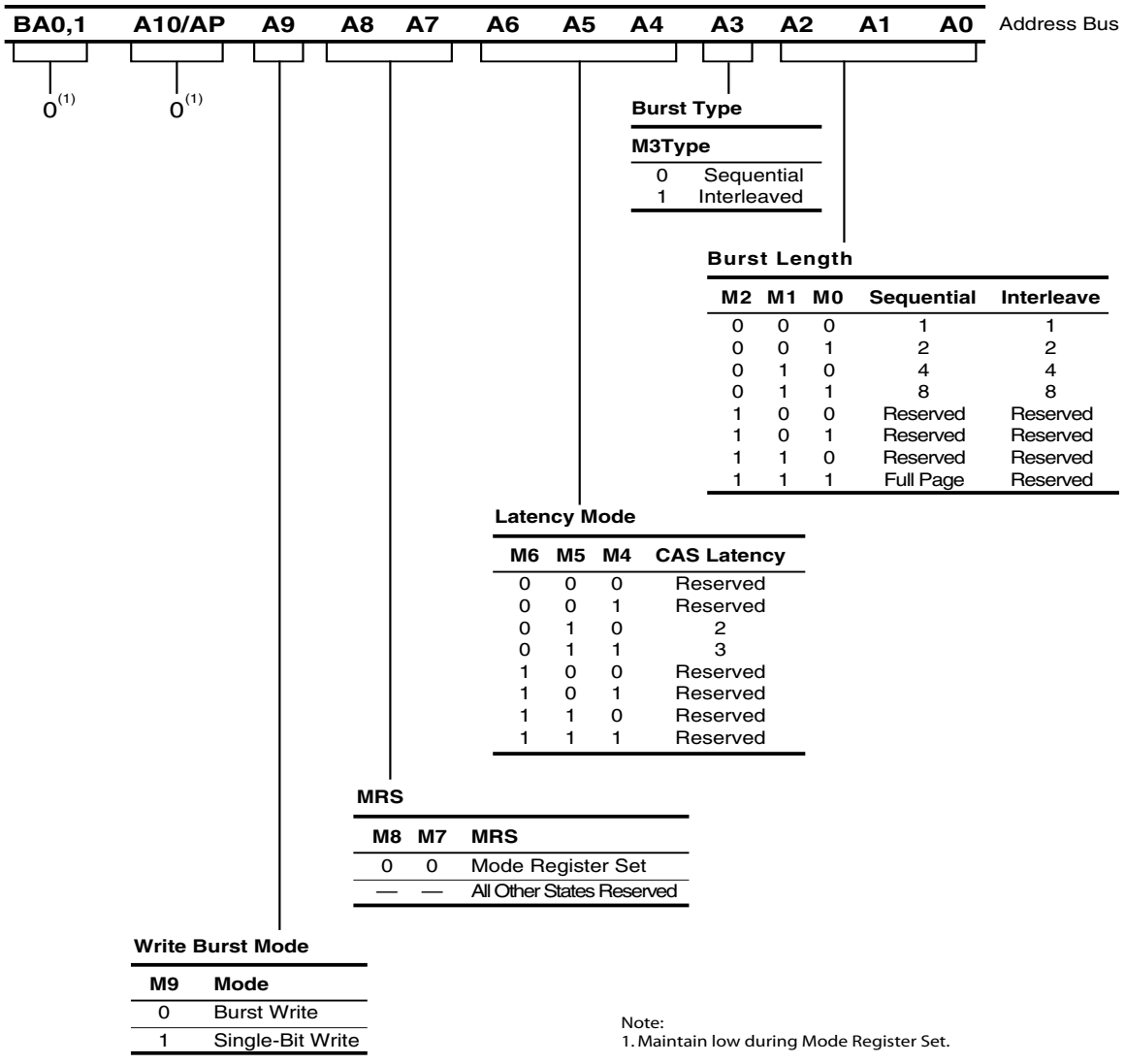
The mode register is used to define the specific mode of operation of the SDRAM. This definition includes the selection of a burst length, a burst type, a CAS\ latency, an operating mode and a write burst mode, as shown in MODE REGISTER DEFINITION.

The mode register is programmed via the LOAD MODE REGISTER command and will retain the stored information until it is programmed again or the device loses power.

Mode register bits M0-M2 specify the burst length, M3 specifies the type of burst (sequential or interleaved), M4- M6 specify the CAS latency, M7 and M8 specify the operating mode, M9 specifies the WRITE burst mode, and M10 and M11 and M12 are reserved for future use.

The mode register must be loaded when all banks are idle, and the controller must wait the specified time before initiating the subsequent operation. Violating either of these requirements will result in unspecified operation.

MODE REGISTER DEFINITION



Burst Type

M3Type	
0	Sequential
1	Interleaved

Burst Length

M2	M1	M0	Sequential	Interleave
0	0	0	1	1
0	0	1	2	2
0	1	0	4	4
0	1	1	8	8
1	0	0	Reserved	Reserved
1	0	1	Reserved	Reserved
1	1	0	Reserved	Reserved
1	1	1	Full Page	Reserved

Latency Mode

M6	M5	M4	CAS Latency
0	0	0	Reserved
0	0	1	Reserved
0	1	0	2
0	1	1	3
1	0	0	Reserved
1	0	1	Reserved
1	1	0	Reserved
1	1	1	Reserved

MRS

M8	M7	MRS
0	0	Mode Register Set
—	—	All Other States Reserved

Write Burst Mode

M9	Mode
0	Burst Write
1	Single-Bit Write

Note:
1. Maintain low during Mode Register Set.

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Burst Length

Read and write accesses to the SDRAM are burst oriented, with the burst length being programmable, as shown in MODE REGISTER DEFINITION. The burst length determines the maximum number of column locations that can be accessed for a given READ or WRITE command. Burst lengths of 1, 2, 4 or 8 locations are available for both the sequential and the interleaved burst types, and a full-page burst is available for the sequential type. The full-page burst is used in conjunction with the BURST TERMINATE command to generate arbitrary burst lengths.

Reserved states should not be used, as unknown operation or incompatibility with future versions may result.

When a READ or WRITE command is issued, a block of columns equal to the burst length is effectively selected. All accesses for that burst take place within this block, meaning that the burst will wrap within the block if a boundary is reached. The block is uniquely selected by A1-A7 (x32) when the burst length is set to two; by A2-A7 (x32) when the burst length is set to four; and by A3-A7 (x32) when the burst length is set to eight. The remaining (least significant) address bit(s) is (are) used to select the starting location within the block. Full-page bursts wrap within the page if the boundary is reached.

Burst Type

Accesses within a given burst may be programmed to be either sequential or interleaved; this is referred to as the burst type and is selected via bit M3.

The ordering of accesses within a burst is determined by the burst length, the burst type and the starting column address, as shown in BURST DEFINITION table.

BURST DEFINITION

Burst Length	Starting Column Address			Order of Accesses Within a Burst	
				Type = Sequential	Type = Interleaved
			A0		
2			0	0-1	0-1
			1	1-0	1-0
		A1	**A0**		
		0	0	0-1-2-3	0-1-2-3
4		0	1	1-2-3-0	1-0-3-2
		1	0	2-3-0-1	2-3-0-1
		1	1	3-0-1-2	3-2-1-0
	A2	**A1**	**A0**		
	0	0	0	0-1-2-3-4-5-6-7	0-1-2-3-4-5-6-7
	0	0	1	1-2-3-4-5-6-7-0	1-0-3-2-5-4-7-6
	0	1	0	2-3-4-5-6-7-0-1	2-3-0-1-6-7-4-5
8	0	1	1	3-4-5-6-7-0-1-2	3-2-1-0-7-6-5-4
	1	0	0	4-5-6-7-0-1-2-3	4-5-6-7-0-1-2-3
	1	0	1	5-6-7-0-1-2-3-4	5-4-7-6-1-0-3-2
	1	1	0	6-7-0-1-2-3-4-5	6-7-4-5-2-3-0-1
	1	1	1	7-0-1-2-3-4-5-6	7-6-5-4-3-2-1-0
Full Page (y)	n = A0-A7 (location 0-y)			Cn, Cn + 1, Cn + 2 Cn + 3, Cn + 4... …Cn - 1, Cn…	Not Supported

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CAS Latency

The CAS latency is the delay, in clock cycles, between the registration of a READ command and the availability of the first piece of output data. The latency can be set to two or three clocks.

If a READ command is registered at clock edge n, and the latency is *m* clocks, the data will be available by clock edge *n* + m. The DQs will start driving as a result of the clock edge one cycle earlier *(n + m* - 1), and provided that the relevant access times are met, the data will be valid by clock edge *n* + m. For example, assuming that the clock cycle time is such that all relevant access times are met, if a READ command is registered at T0 and the latency is programmed to two clocks, the DQs will start driving after T1 and the data will be valid by T2, as shown in CAS Latency diagrams. The **Allowable Operating Frequency** table indicates the operating frequencies at which each CAS latency setting can be used.

Reserved states should not be used as unknown operation or incompatibility with future versions may result.

Operating Mode

The normal operating mode is selected by setting M7 and M8 to zero; the other combinations of values for M7 and M8 are reserved for future use and/or test modes. The programmed burst length applies to both READ and WRITE bursts.

Test modes and reserved states should not be used because unknown operation or incompatibility with future versions may result.

Write Burst Mode

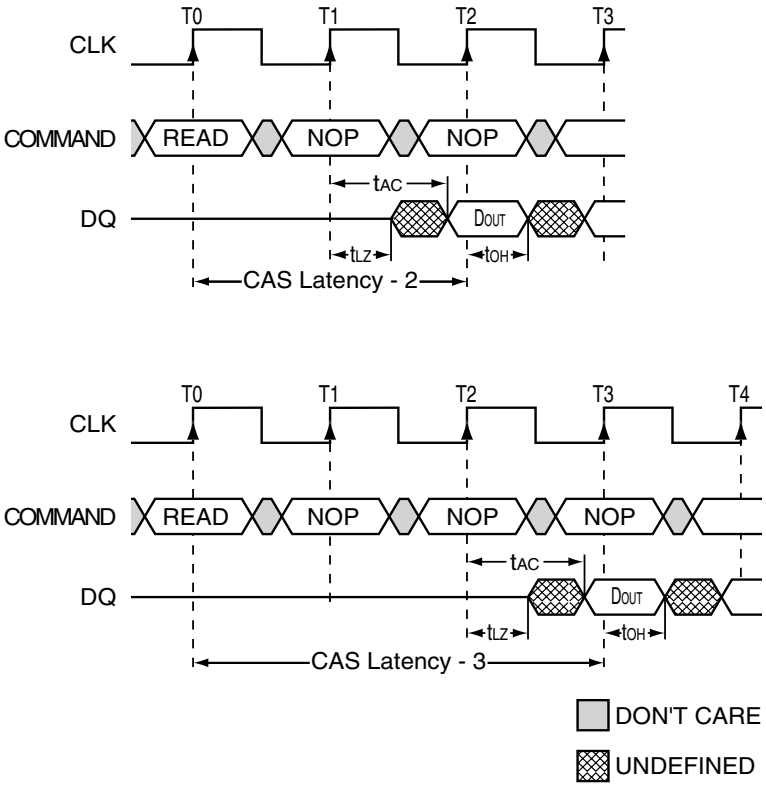
When M9 = 0, the burst length programmed via M0-M2 applies to both READ and WRITE bursts; when M9 = 1, the programmed burst length applies to READ bursts, but write accesses are single-location (nonburst) accesses.

CAS Latency

Allowable Operating Frequency (MHz)

Speed	CAS Latency = 2	CAS Latency = 3
-5	133	200
-6	133	166
-7	133	143

CAS Latency



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OPERATION

BANK/ROW ACTIVATION

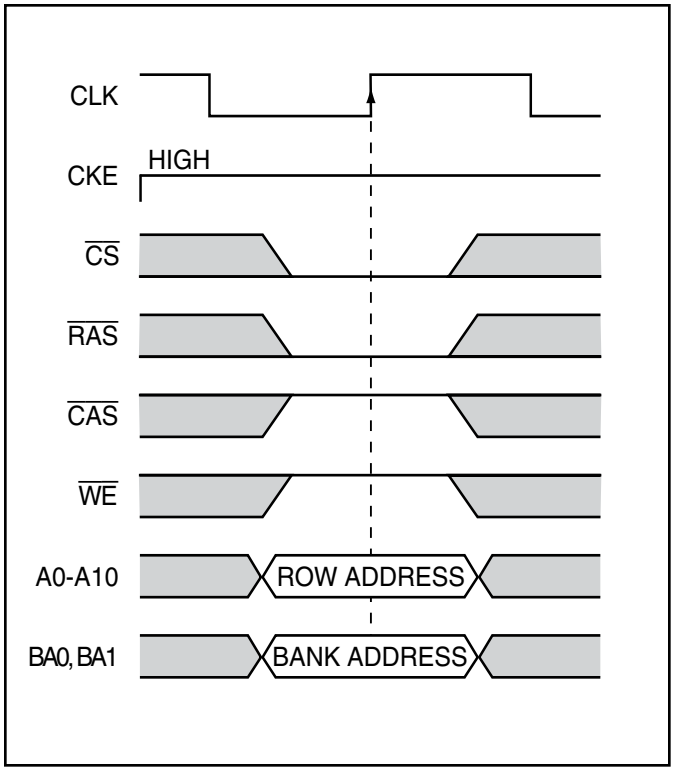
Before any READ or WRITE commands can be issued to a bank within the SDRAM, a row in that bank must be "opened." This is accomplished via the ACTIVE command, which selects both the bank and the row to be activated (see Activating Specific Row Within Specific Bank).

After opening a row (issuing an ACTIVE command), a READ or WRITE command may be issued to that row, subject to the t_{RCD} specification. Minimum t_{RCD} should be divided by the clock period and rounded up to the next whole number to determine the earliest clock edge after the ACTIVE command on which a READ or WRITE command can be entered. For example, a t_{RCD} specification of 20ns with a 125 MHz clock (8ns period) results in 2.5 clocks, rounded to 3. This is reflected in the following example, which covers any case where $2 < [t_{RCD} (MIN)/t_{CK}] \leq 3$. (The same procedure is used to convert other specification limits from time units to clock cycles).

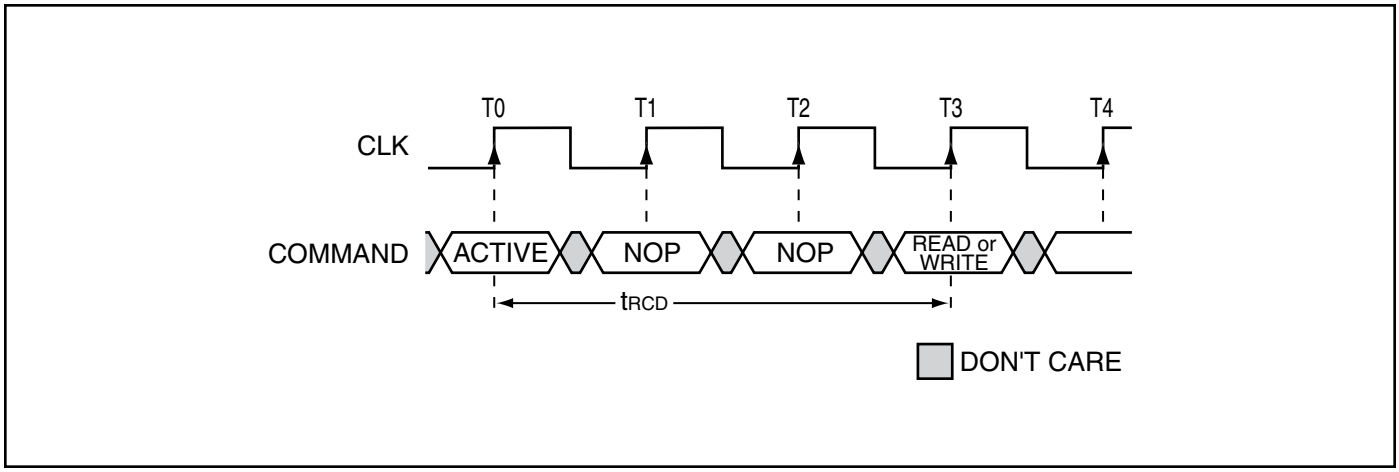
A subsequent ACTIVE command to a different row in the same bank can only be issued after the previous active row has been "closed" (precharged). The minimum time interval between successive ACTIVE commands to the same bank is defined by t_{RC}.

A subsequent ACTIVE command to another bank can be issued while the first bank is being accessed, which results in a reduction of total row-access overhead. The minimum time interval between successive ACTIVE commands to different banks is defined by t_{RRD}.

Activating Specific Row Within Specific Bank



Example: Meeting t_{RCD} (MIN) when $2 < [t_{RCD} (min)/t_{CK}] \leq 3$



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READS

READ bursts are initiated with a READ command, as shown in the READ COMMAND diagram.

The starting column and bank addresses are provided with the READ command, and auto precharge is either enabled or disabled for that burst access. If auto precharge is enabled, the row being accessed is precharged at the completion of the burst. For the generic READ commands used in the following illustrations, auto precharge is disabled.

During READ bursts, the valid data-out element from the starting column address will be available following the CAS latency after the READ command. Each subsequent data-out element will be valid by the next positive clock edge. The CAS Latency diagram shows general timing for each possible CAS latency setting.

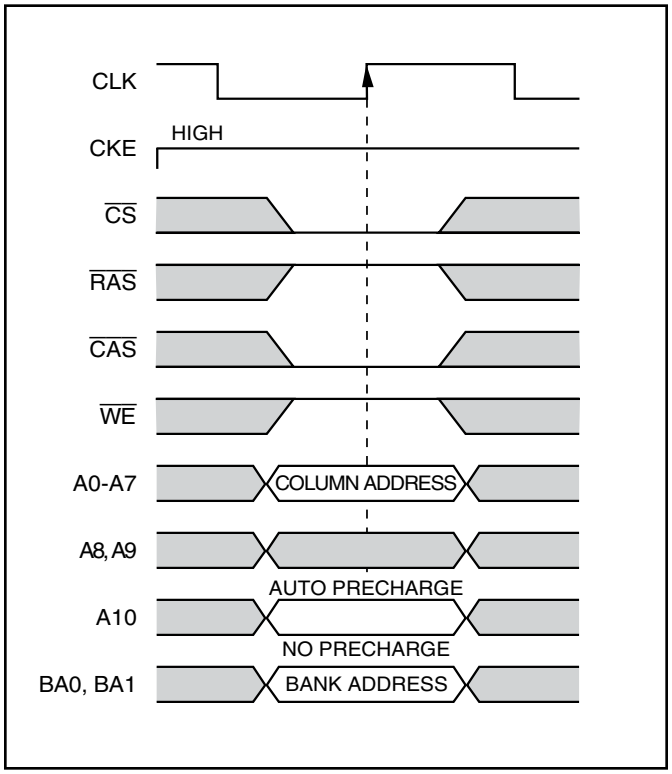
Upon completion of a burst, assuming no other commands have been initiated, the DQs will go High-Z. A full-page burst will continue until terminated. (At the end of the page, it will wrap to column 0 and continue.)

Data from any READ burst may be truncated with a subsequent READ command, and data from a fixed-length READ burst may be immediately followed by data from a READ command. In either case, a continuous flow of data can be maintained. The first data element from the new burst follows either the last element of a completed burst or the last desired data element of a longer burst which is being truncated.

The new READ command should be issued *x* cycles before the clock edge at which the last desired data element is valid, where *x* equals the CAS latency minus one. This is shown in Consecutive READ Bursts for CAS latencies of two and three; data element *n* + 3 is either the last of a burst of four or the last desired of a longer burst. The 64Mb SDRAM uses a pipelined architecture and therefore does not require the *2n* rule associated with a prefetch architecture. A READ command can be initiated on any clock cycle following a previous READ command. Full-speed random read accesses can be performed to the same bank, as shown in Random READ Accesses, or each subsequent READ may be performed to a different bank.

Data from any READ burst may be truncated with a subsequent WRITE command, and data from a fixed-length READ burst may be immediately followed by data from a WRITE command (subject to bus turnaround limitations). The WRITE burst may be initiated on the clock edge immediately following the last (or last desired) data element from the READ burst, provided that DQ contention can be avoided. In a given system design, there may be a possibility that the device driving the input data will go Low-Z before the SDRAM DQs go High-Z. In this case, at least a single-cycle delay should occur between the last read data and the WRITE command.

READ COMMAND



The DQM input is used to avoid DQ contention, as shown in Figures RW1 and RW2. The DQM signal must be asserted (HIGH) at least two clocks prior to the WRITE command (DQM latency is two clocks for output buffers) to suppress data-out from the READ. Once the WRITE command is registered, the DQs will go High-Z (or remain High-Z), regardless of the state of the DQM signal, provided the DQM was active on the clock just prior to the WRITE command that truncated the READ command. If not, the second WRITE will be an invalid WRITE. For example, if DQM was LOW during T4 in Figure RW2, then the WRITEs at T5 and T7 would be valid, while the WRITE at T6 would be invalid.

The DQM signal must be de-asserted prior to the WRITE command (DQM latency is zero clocks for input buffers) to ensure that the written data is not masked. Figure RW1 shows the case where the clock frequency allows for bus contention to be avoided without adding a NOP cycle, and Figure RW2 shows the case where the additional NOP is needed.

A fixed-length READ burst may be followed by, or truncated with, a PRECHARGE command to the same bank (provided that auto precharge was not activated), and a full-page burst may be truncated with a PRECHARGE command to the

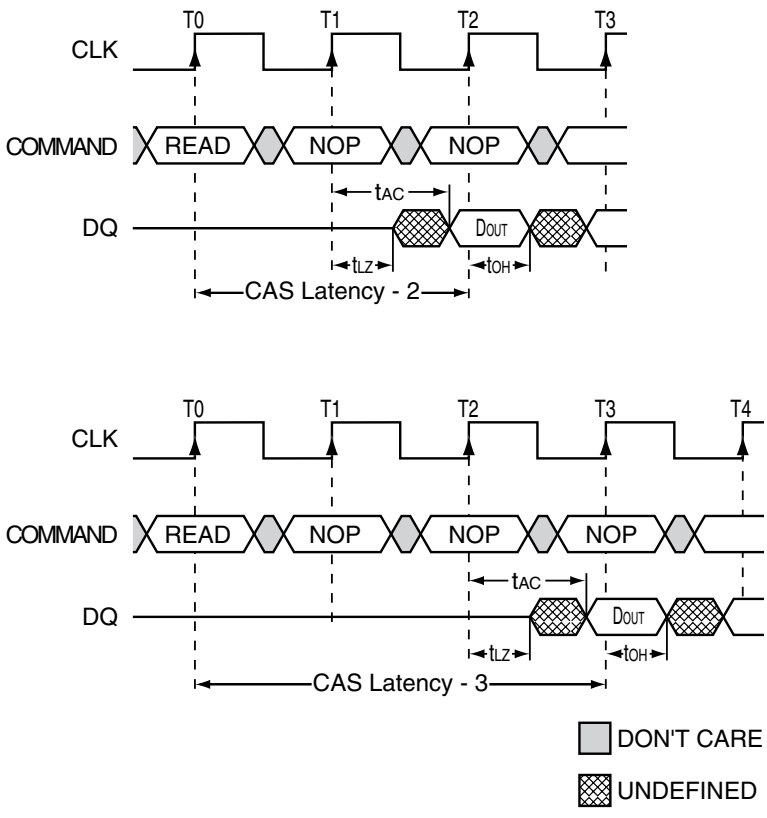
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same bank. The PRECHARGE command should be issued *x* cycles before the clock edge at which the last desired data element is valid, where *x* equals the CAS latency minus one. This is shown in the READ to PRECHARGE diagram for each possible CAS latency; data element *n* + 3 is either the last of a burst of four or the last desired of a longer burst. Following the PRECHARGE command, a subsequent command to the same bank cannot be issued until t_{RP} is met. Note that part of the row precharge time is hidden during the access of the last data element(s).

In the case of a fixed-length burst being executed to completion, a PRECHARGE command issued at the optimum time (as described above) provides the same operation that would result from the same fixed-length burst with auto precharge. The disadvantage of the PRECHARGE command is that it requires that the command and address buses be available at the appropriate time to issue the command; the advantage of the PRECHARGE command is that it can be used to truncate fixed-length or full-page bursts.

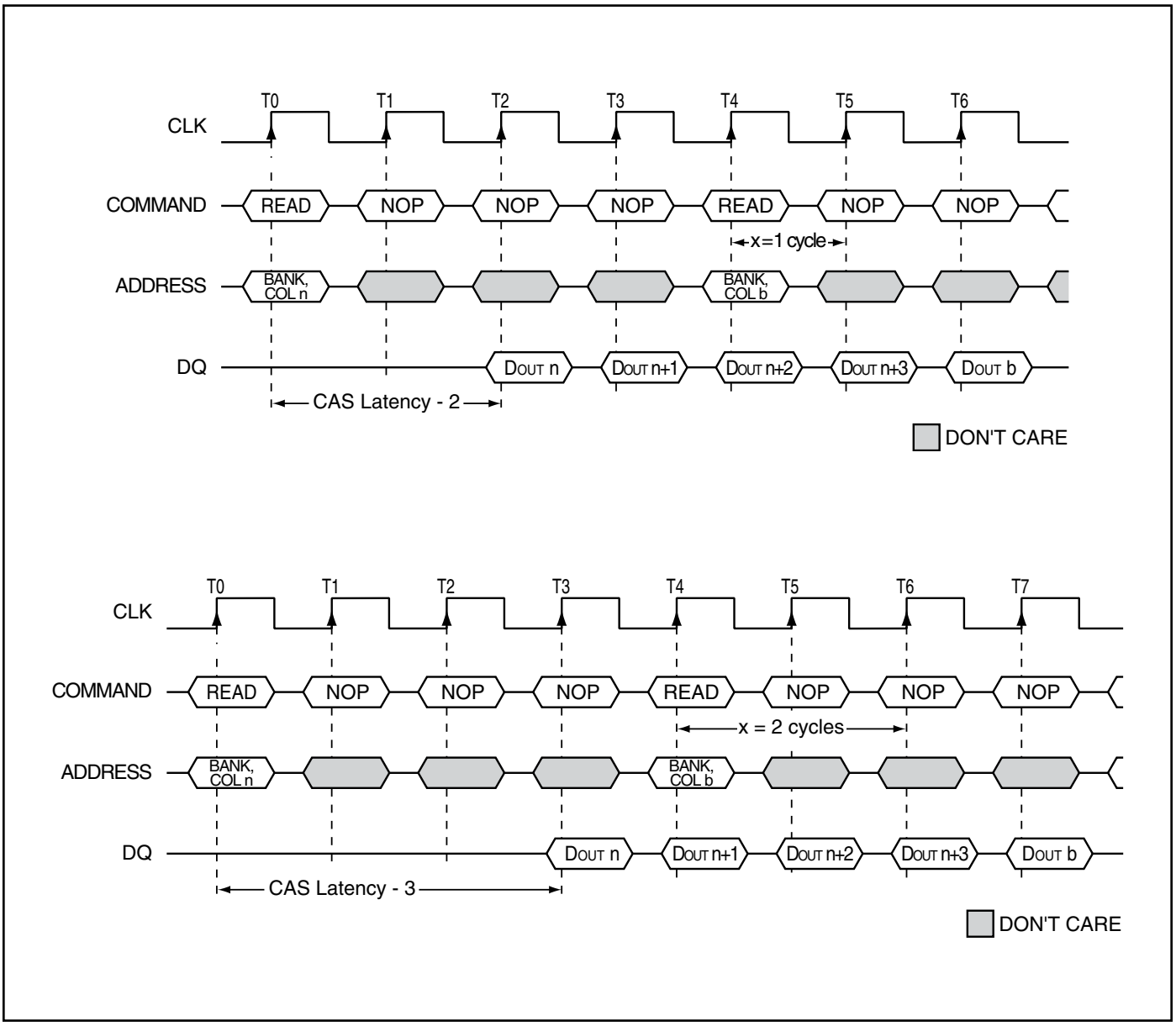
Full-page READ bursts can be truncated with the BURST TERMINATE command, and fixed-length READ bursts may be truncated with a BURST TERMINATE command, provided that auto precharge was not activated. The BURST TERMINATE command should be issued *x* cycles before the clock edge at which the last desired data element is valid, where *x* equals the CAS latency minus one. This is shown in the READ Burst Termination diagram for each possible CAS latency; data element *n* + 3 is the last desired data element of a longer burst.

CAS Latency



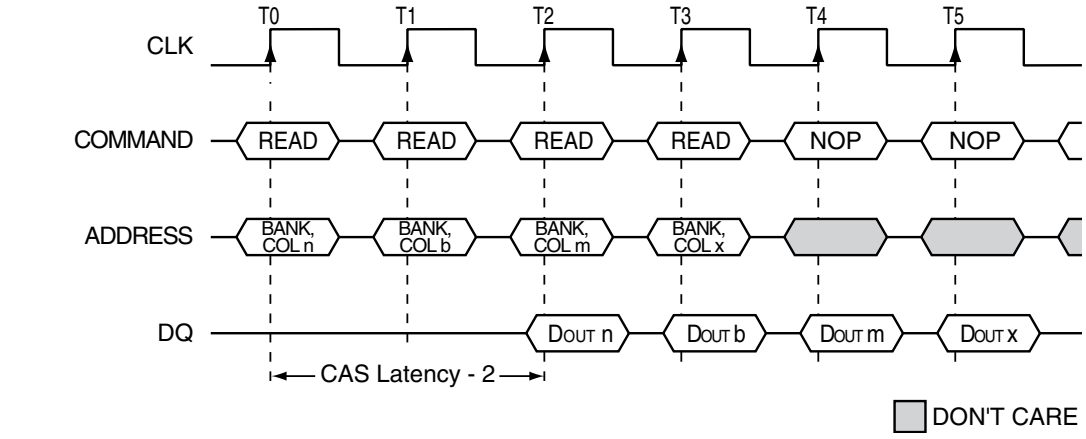
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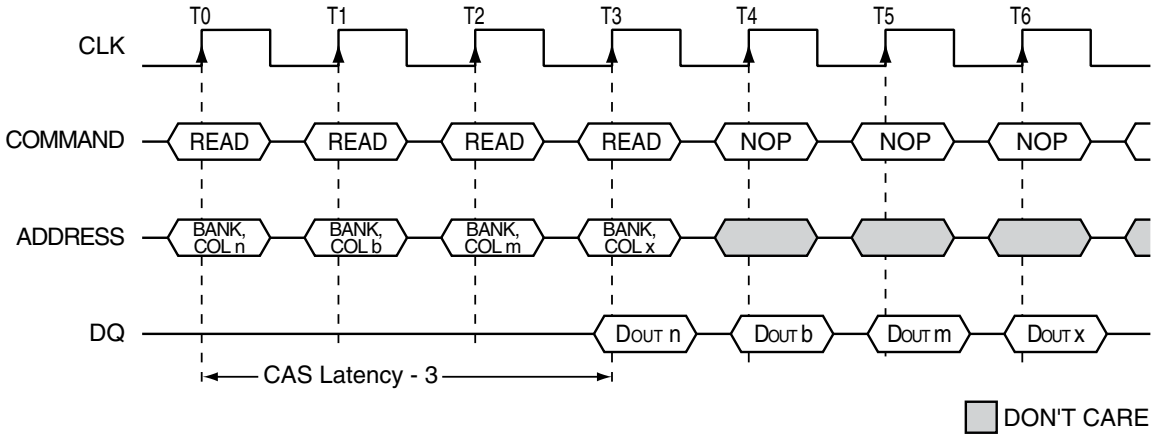
Consecutive READ Bursts



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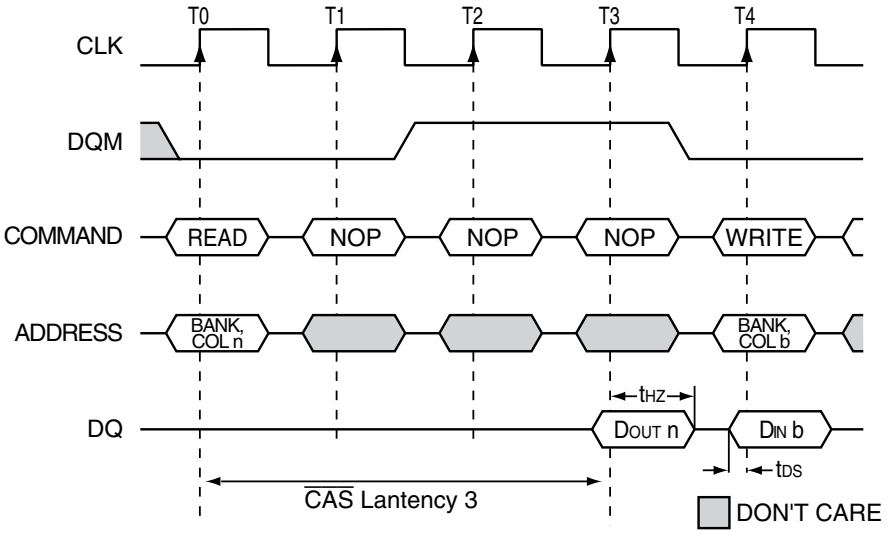
Random READ Accesses



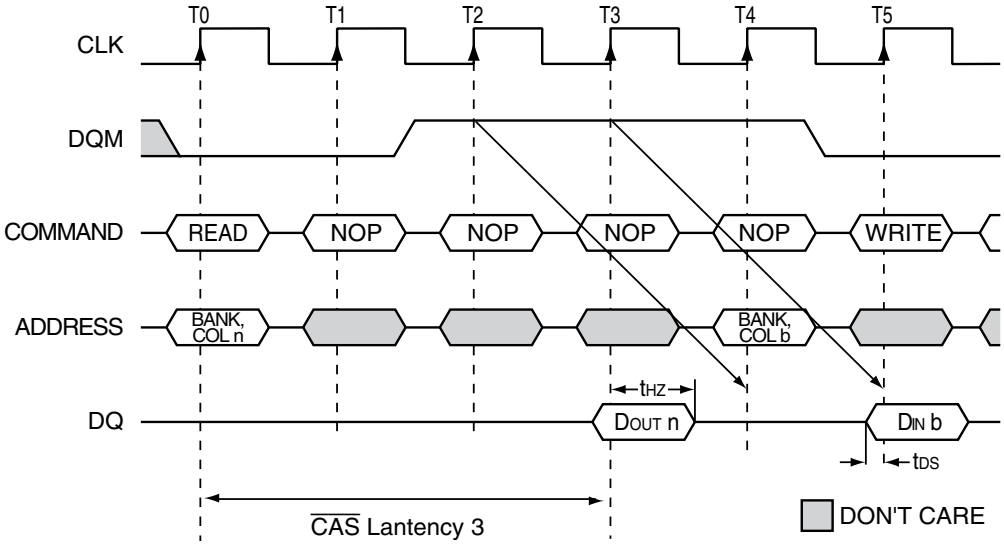


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RW1 - READ to WRITE

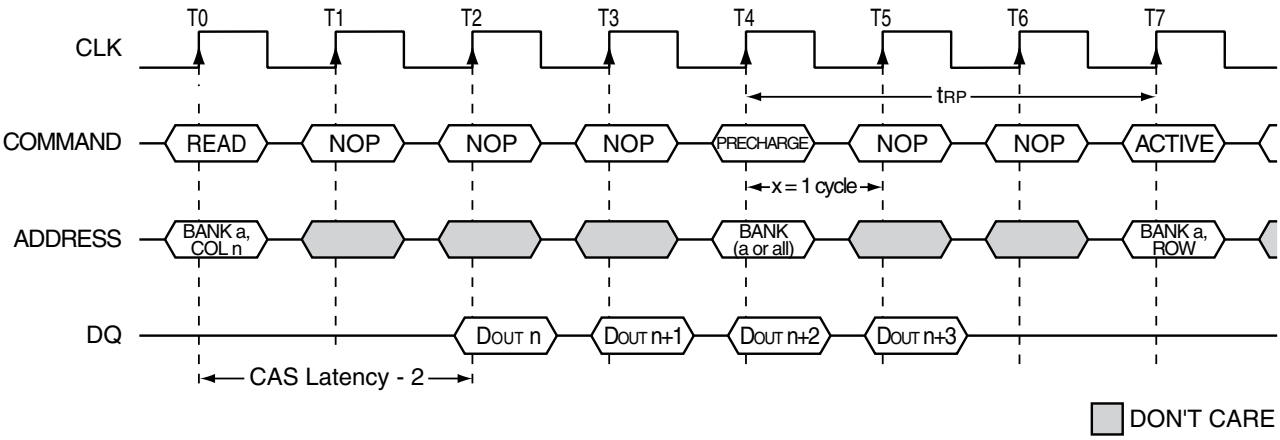


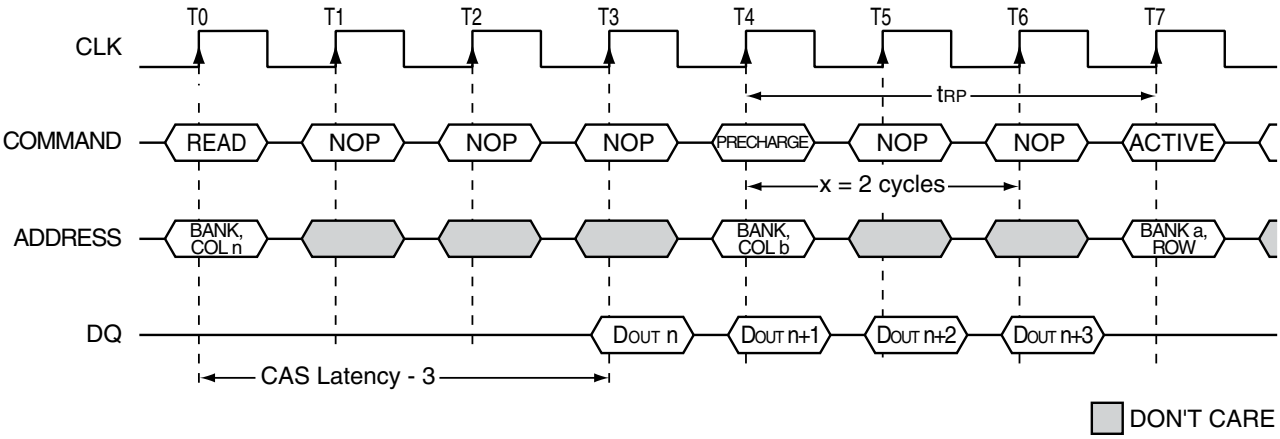
RW2 - READ to WRITE With Extra Clock Cycle



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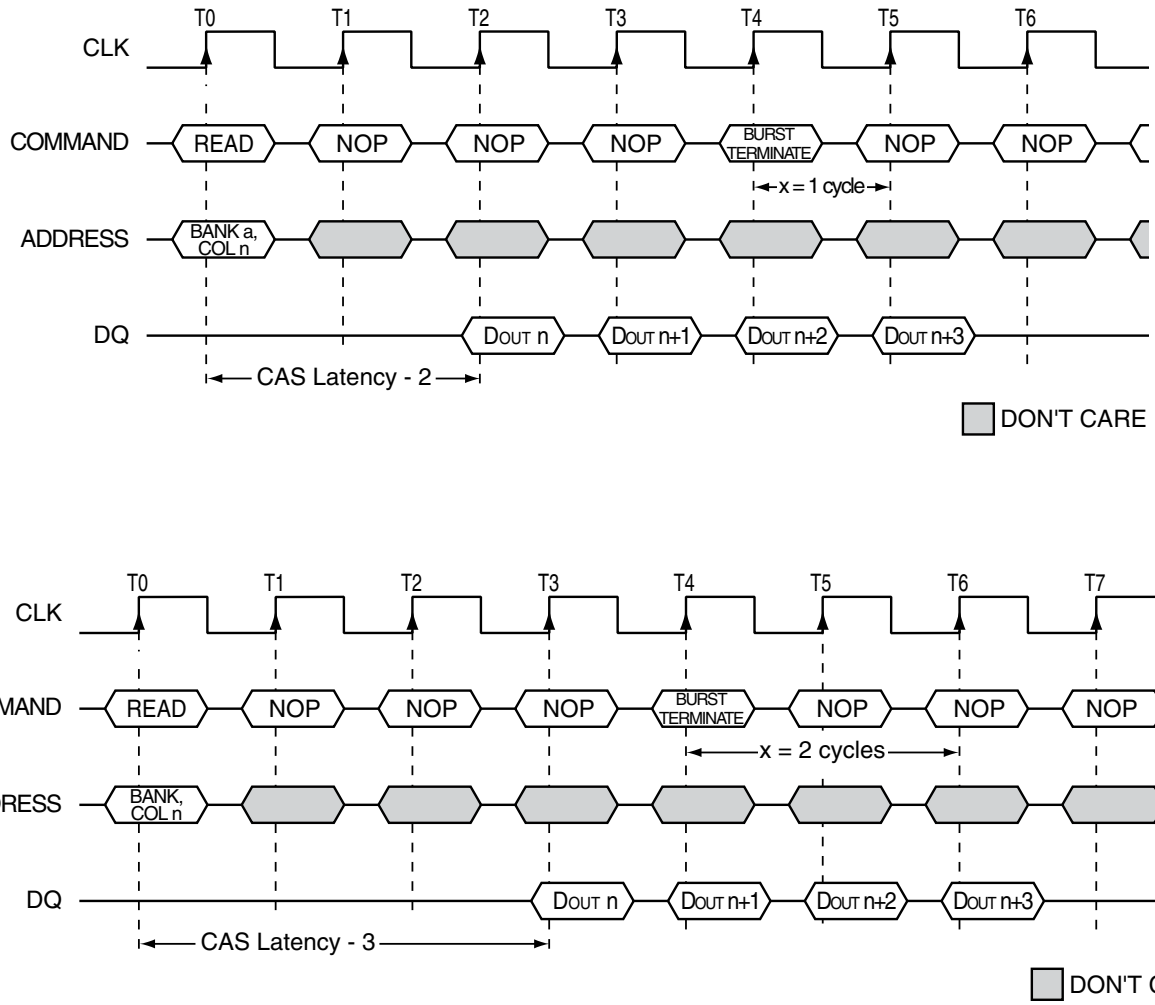
READ to PRECHARGE





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READ Burst Termination

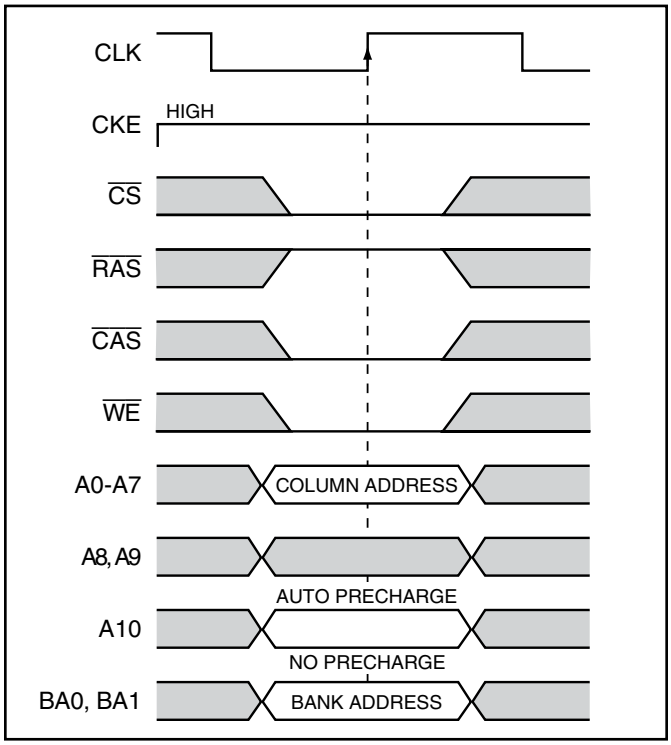


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WRITEs

WRITE bursts are initiated with a WRITE command, as shown in WRITE Command diagram.

WRITE Command



The starting column and bank addresses are provided with the WRITE command, and auto precharge is either enabled or disabled for that access. If auto precharge is enabled, the row being accessed is precharged at the completion of the burst. For the generic WRITE commands used in the following illustrations, auto precharge is disabled.

During WRITE bursts, the first valid data-in element will be registered coincident with the WRITE command. Subsequent data elements will be registered on each successive positive clock edge. Upon completion of a fixed-length burst, assuming no other commands have been initiated, the DQs will remain High-Z and any additional input data will be ignored (see WRITE Burst). A full-page burst will continue until terminated. (At the end of the page, it will wrap to column 0 and continue.)

Data for any WRITE burst may be truncated with a subsequent WRITE command, and data for a fixed-length WRITE burst may be immediately followed by data for a WRITE command. The new WRITE command can be issued on any clock following the previous WRITE command, and the data provided coincident with the new command applies to the new command.

An example is shown in WRITE to WRITE diagram. Data *n* + 1 is either the last of a burst of two or the last desired of a longer burst. The 64Mb SDRAM uses a pipelined architecture and therefore does not require the *2n* rule associated with a prefetch architecture. A WRITE command can be initiated on any clock cycle following a previous WRITE command. Full-speed random write accesses within a page can be performed to the same bank, as shown in Random WRITE Cycles, or each subsequent WRITE may be performed to a different bank.

Data for any WRITE burst may be truncated with a subsequent READ command, and data for a fixed-length WRITE burst may be immediately followed by a subsequent READ command. Once the READ com mand is registered, the data inputs will be ignored, and WRITEs will not be executed. An example is shown in WRITE to READ. Data *n* + 1 is either the last of a burst of two or the last desired of a longer burst.

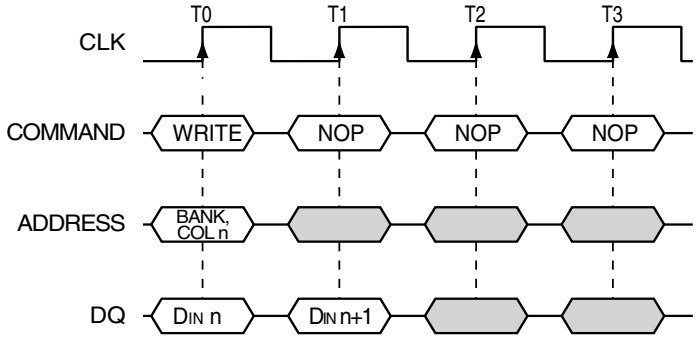
Data for a fixed-length WRITE burst may be fol lowed by, or truncated with, a PRECHARGE command to the same bank (provided that auto precharge was not activated), and a full-page WRITE burst may be truncated with a PRECHARGE command to the same bank. The PRECHARGE command should be issued t_{WR} after the clock edge at which the last desired input data element is registered. The auto precharge mode requires a t_{WR} of at least one clock plus time, regardless of frequency. In addition, when truncating a WRITE burst, the DQM signal must be used to mask input data for the clock edge prior to, and the clock edge coincident with, the PRECHARGE command. An example is shown in the WRITE to PRECHARGE diagram. Data *n*+1 is either the last of a burst of two or the last desired of a longer burst. Following the PRECHARGE command, a subsequent command to the same bank cannot be issued until t_{RP} is met.

In the case of a fixed-length burst being executed to completion, a PRECHARGE command issued at the optimum time (as described above) provides the same operation that would result from the same fixed-length burst with auto precharge. The disadvantage of the PRECHARGE command is that it requires that the command and address buses be available at the appropriate time to issue the command; the advantage of the PRECHARGE command is that it can be used to truncate fixed-length or full-page bursts.

Fixed-length or full-page WRITE bursts can be truncated with the BURST TERMINATE command. When truncating a WRITE burst, the input data applied coincident with the BURST TERMINATE command will be ignored. The last data written (provided that DQM is LOW at that time) will be the input data applied one clock previous to the BURST TERMINATE command. This is shown in WRITE Burst Termination, where data *n* is the last desired data element of a longer burst.

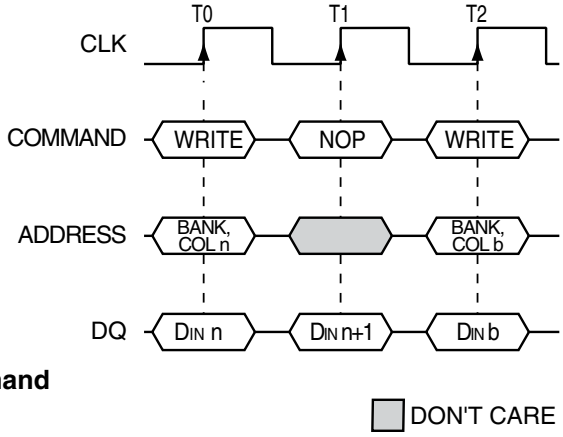
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WRITE Burst



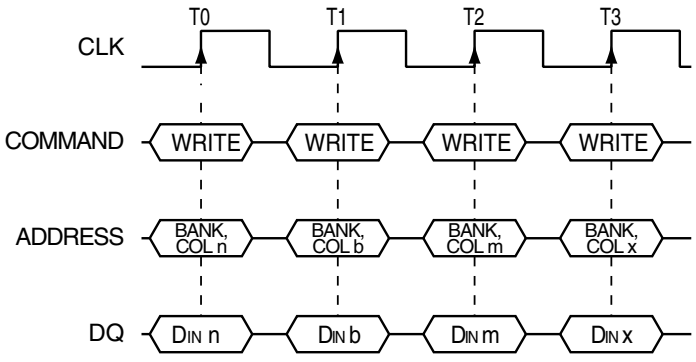
Burst length = 2 DQM ix low.

WRITE to WRITE



DQMx is low. Each Write Command may be to any bank.

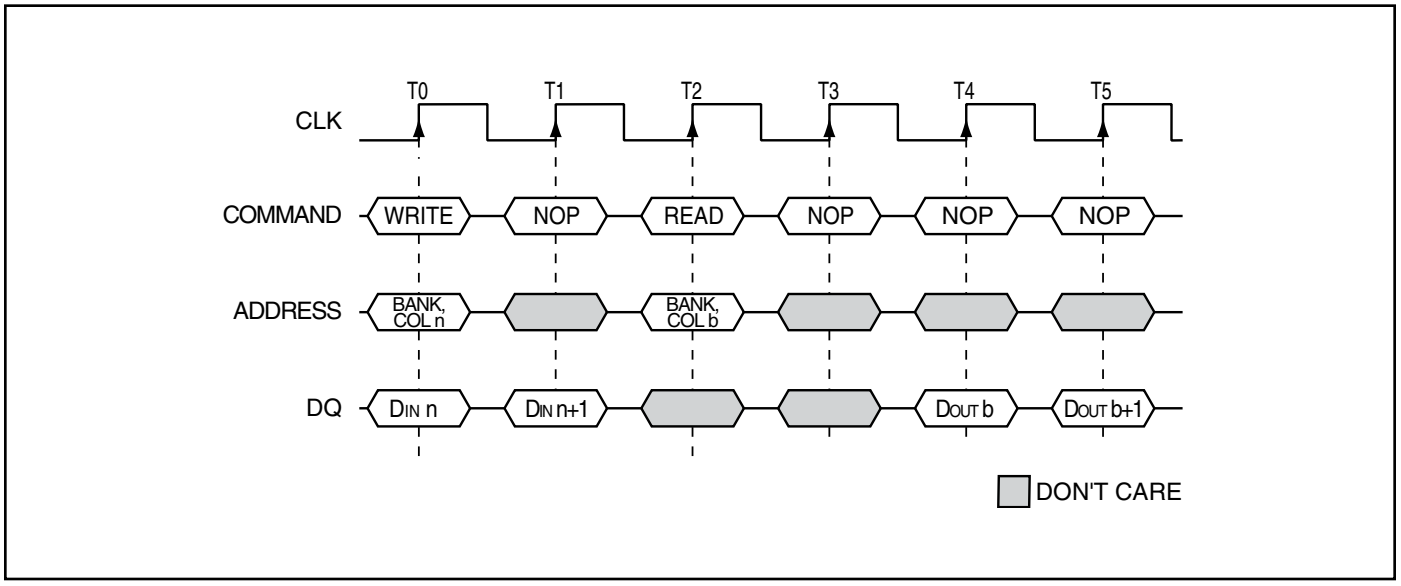
Random WRITE Cycles



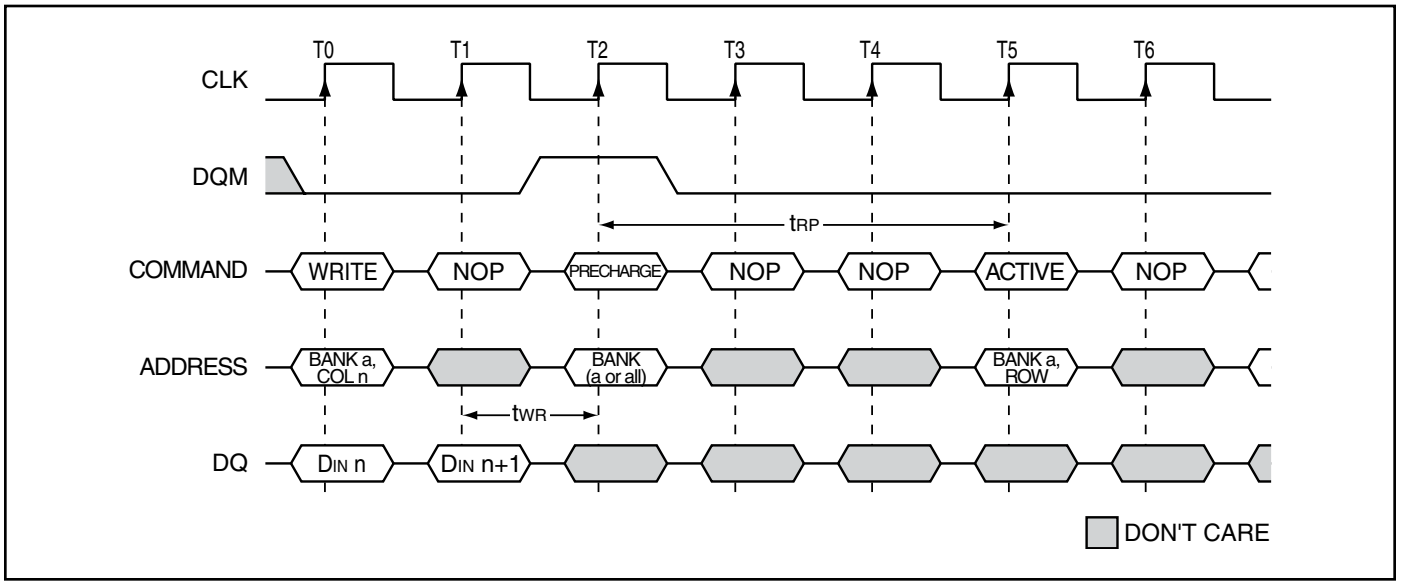
DQMx is low. Each Write Command may be to any bank.

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WRITE to READ

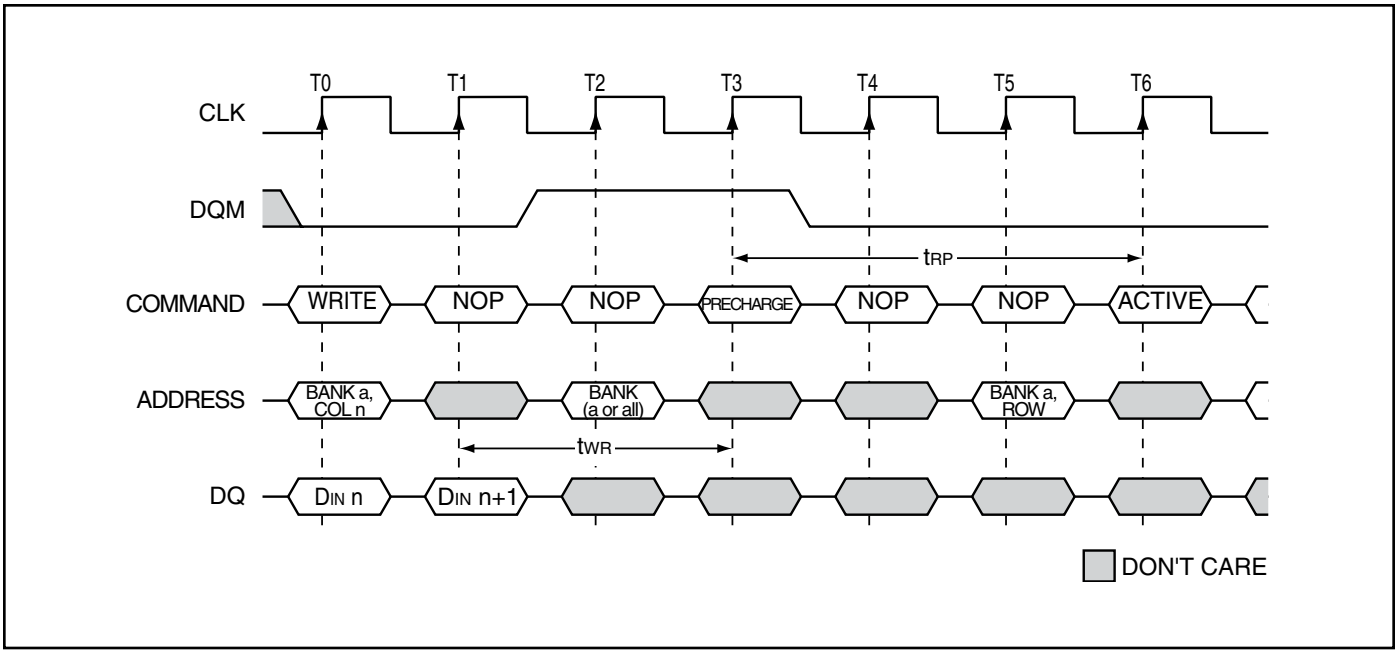


WRITE to PRECHARGE (t_{WR} = 1 CLK ($t_{CK} \geq t_{WR}$)

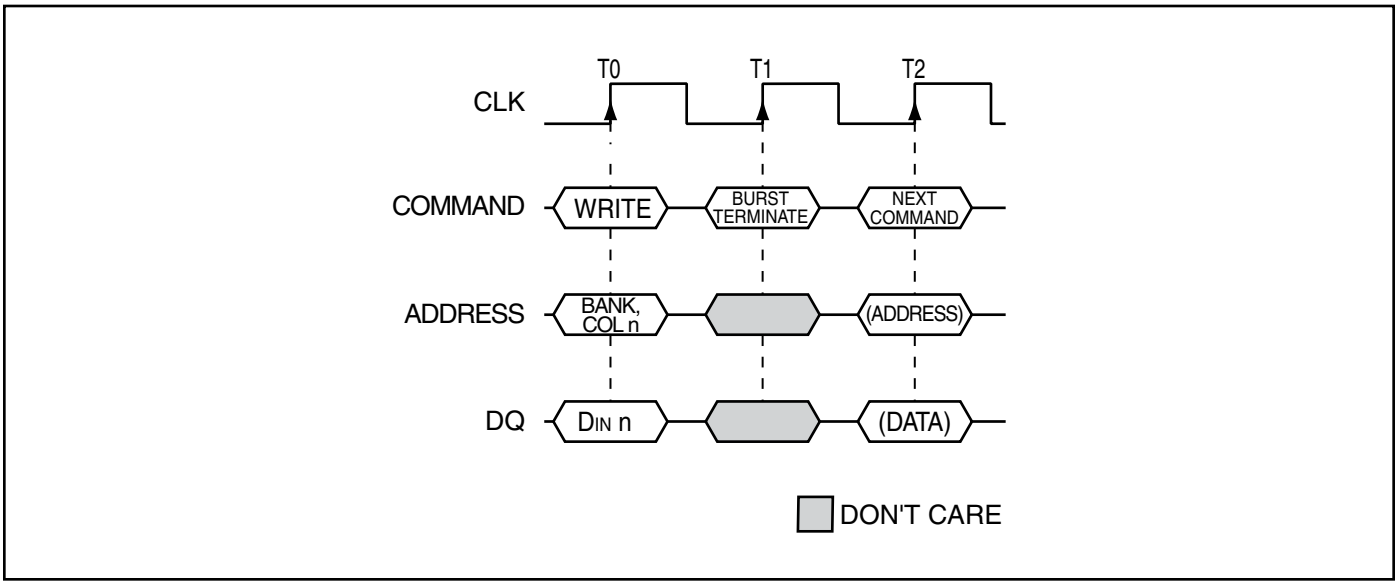


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WRITE to PRECHARGE (t_{WR} = 2 CLK (t_{WR} > t_{CK})



WRITE Burst Termination

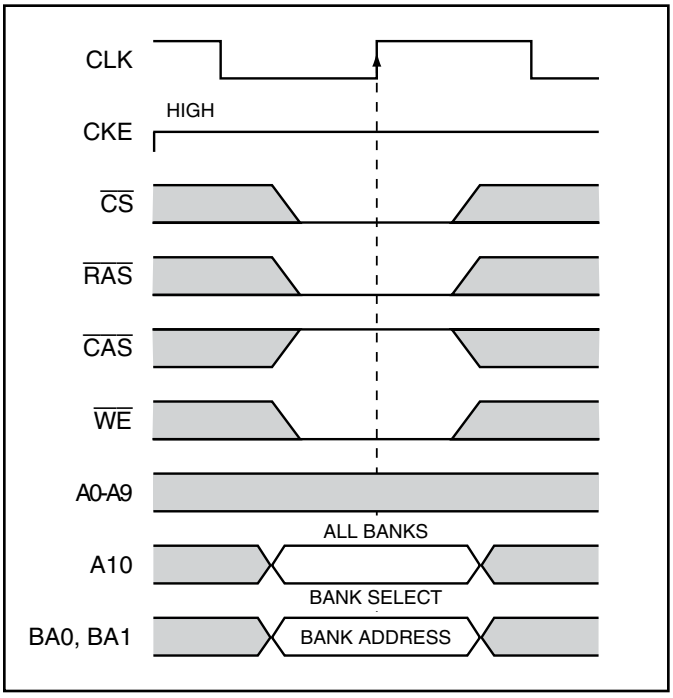


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PRECHARGE

The PRECHARGE command (see figure) is used to deactivate the open row in a particular bank or the open row in all banks. The bank(s) will be available for a subsequent row access some specified time (t_{RP}) after the PRECHARGE command is issued. Input A10 determines whether one or all banks are to be precharged, and in the case where only one bank is to be precharged, inputs BA0, BA1 select the bank. When all banks are to be precharged, inputs BA0, BA1 are treated as "Don't Care." Once a bank has been precharged, it is in the idle state and must be activated prior to any READ or WRITE commands being issued to that bank.

PRECHARGE Command

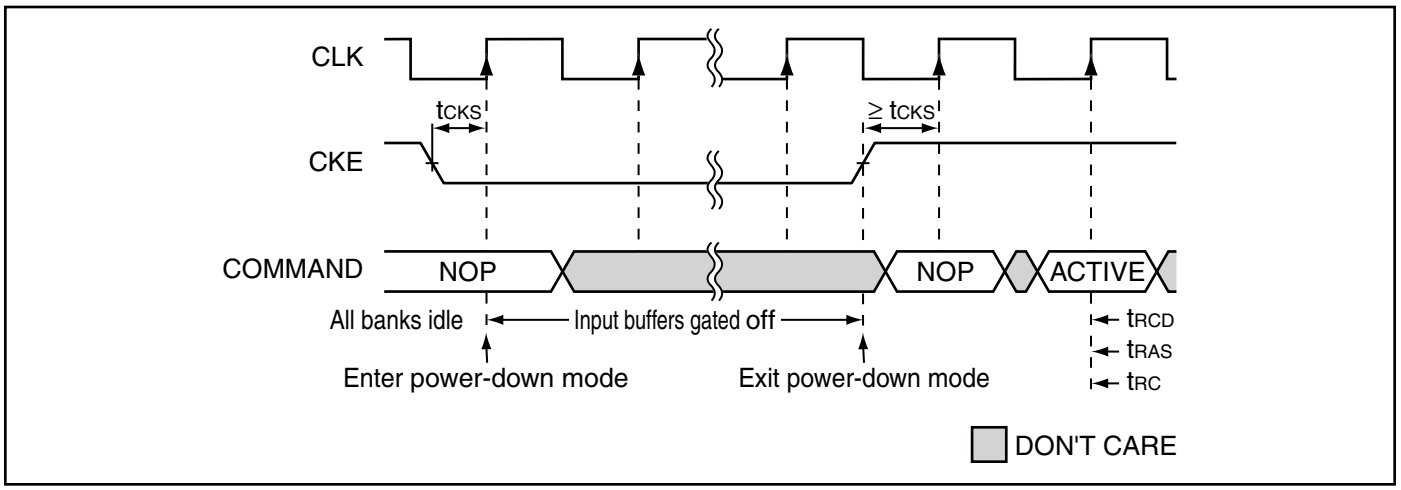


POWER-DOWN

Power-down occurs if CKE is registered LOW coincident with a NOP or COMMAND INHIBIT when no accesses are in progress. If power-down occurs when all banks are idle, this mode is referred to as precharge power-down; if power-down occurs when there is a row active in either bank, this mode is referred to as active power-down. Entering power-down deactivates the input and output buffers, excluding CKE, for maximum power savings while in standby. The device may not remain in the power-down state longer than the refresh period (t_{REF}) since no refresh operations are performed in this mode.

The power-down state is exited by registering a NOP or COMMAND INHIBIT and CKE HIGH at the desired clock edge (meeting t_{CKS}). See figure below.

POWER-DOWN



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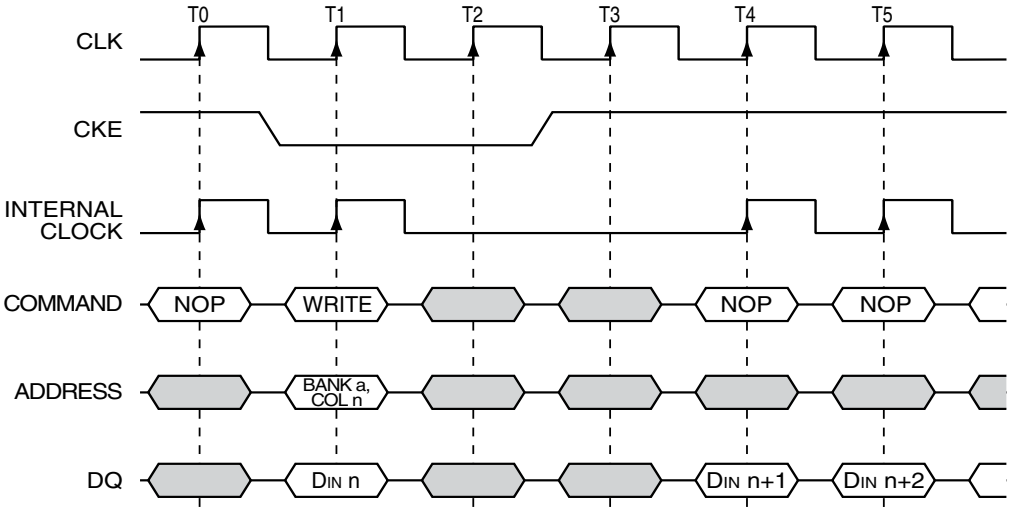
CLOCK SUSPEND

Clock suspend mode occurs when a column access/burst is in progress and CKE is registered LOW. In the clock suspend mode, the internal clock is deactivated, “freezing” the synchronous logic.

For each positive clock edge on which CKE is sampled LOW, the next internal positive clock edge is suspended. Any command or data present on the input pins at the time of a suspended internal clock edge is ignored; any data present on the DQ pins remains driven; and burst counters are not incremented, as long as the clock is suspended. (See following examples.)

Clock suspend mode is exited by registering CKE HIGH; the internal clock and related operation will resume on the subsequent positive clock edge.

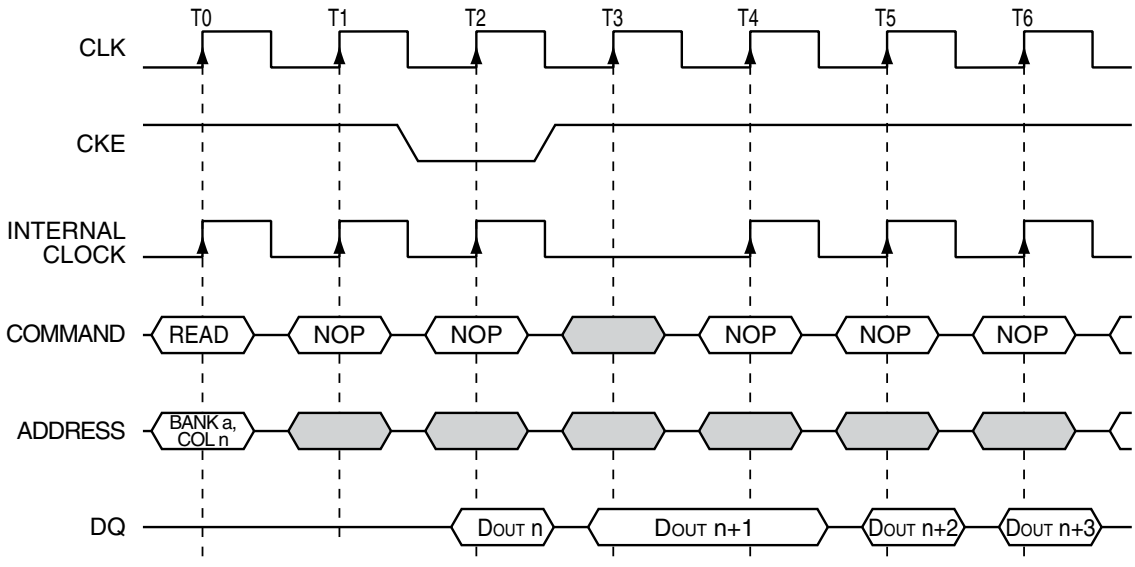
Clock Suspend During WRITE Burst



Burst Length 4 or greater DQM is low.

DON'T CARE

Clock Suspend During READ Burst



CAS Latency=2. Burst Length =4 or greater. DQM is low.

DON'T CARE

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BURST READ/SINGLE WRITE

The burst read/single write mode is entered by programming the write burst mode bit (M9) in the mode register to a logic 1. In this mode, all WRITE commands result in the access of a single column location (burst of one), regardless of the programmed burst length. READ commands access columns according to the programmed burst length and sequence, just as in the normal mode of operation (M9 = 0).

CONCURRENT AUTO PRECHARGE

An access command (READ or WRITE) to another bank while an access command with auto precharge enabled is executing is not allowed by SDRAMs, unless the SDRAM supports CONCURRENT AUTO PRECHARGE. *ISSI* SDRAMs support CONCURRENT AUTO PRECHARGE. Four cases where CONCURRENT AUTO PRECHARGE occurs are defined below.

READ with Auto Precharge

1. Interrupted by a READ (with or without auto precharge): A READ to bank m will interrupt a READ on bank n, CAS latency later. The PRECHARGE to bank n will begin when the READ to bank m is registered.
2. Interrupted by a WRITE (with or without auto precharge): A WRITE to bank m will interrupt a READ on bank n when registered. DQM should be used two clocks prior to the WRITE command to prevent bus contention. The PRECHARGE to bank n will begin when the WRITE to bank m is registered.

Fig CAP 1 - READ With Auto Precharge interrupted by a READ

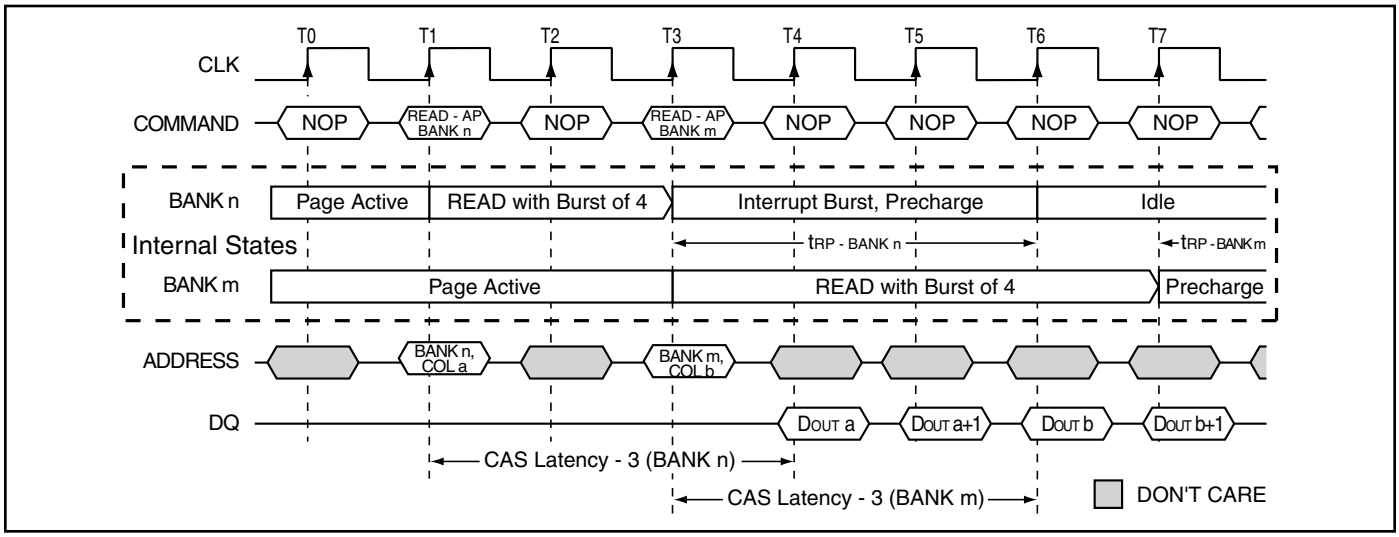
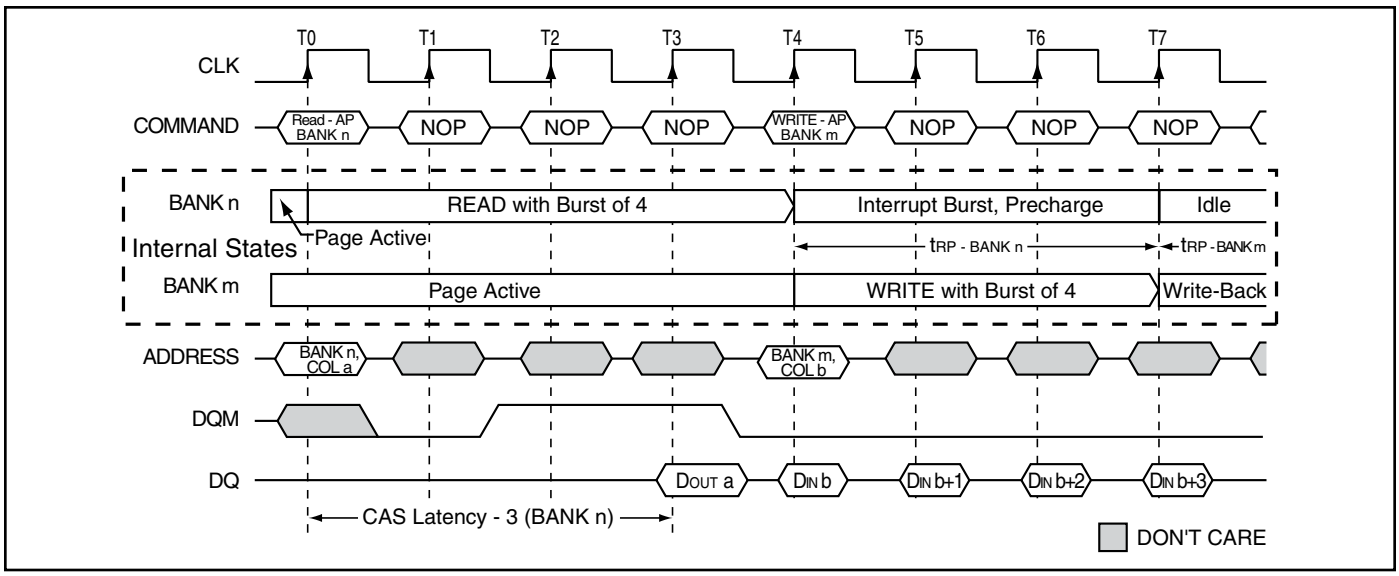


Fig CAP 2 - READ With Auto Precharge interrupted by a WRITE



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WRITE with Auto Precharge

3. Interrupted by a READ (with or without auto precharge): A READ to bank m will interrupt a WRITE on bank n when registered, with the data-out appearing CAS latency later. The PRECHARGE to bank n will begin after tWR is met, where tWR begins when the READ to bank m is registered. The last valid WRITE to bank n will be data-in registered one clock prior to the READ to bank m.

4. Interrupted by a WRITE (with or without auto precharge): AWRITE to bank m will interrupt a WRITE on bank n when registered. The PRECHARGE to bank n will begin after tWR is met, where tWR begins when the WRITE to bank m is registered. The last valid data WRITE to bank n will be data registered one clock prior to a WRITE to bank m.

Fig CAP 3 - WRITE With Auto Precharge interrupted by a READ

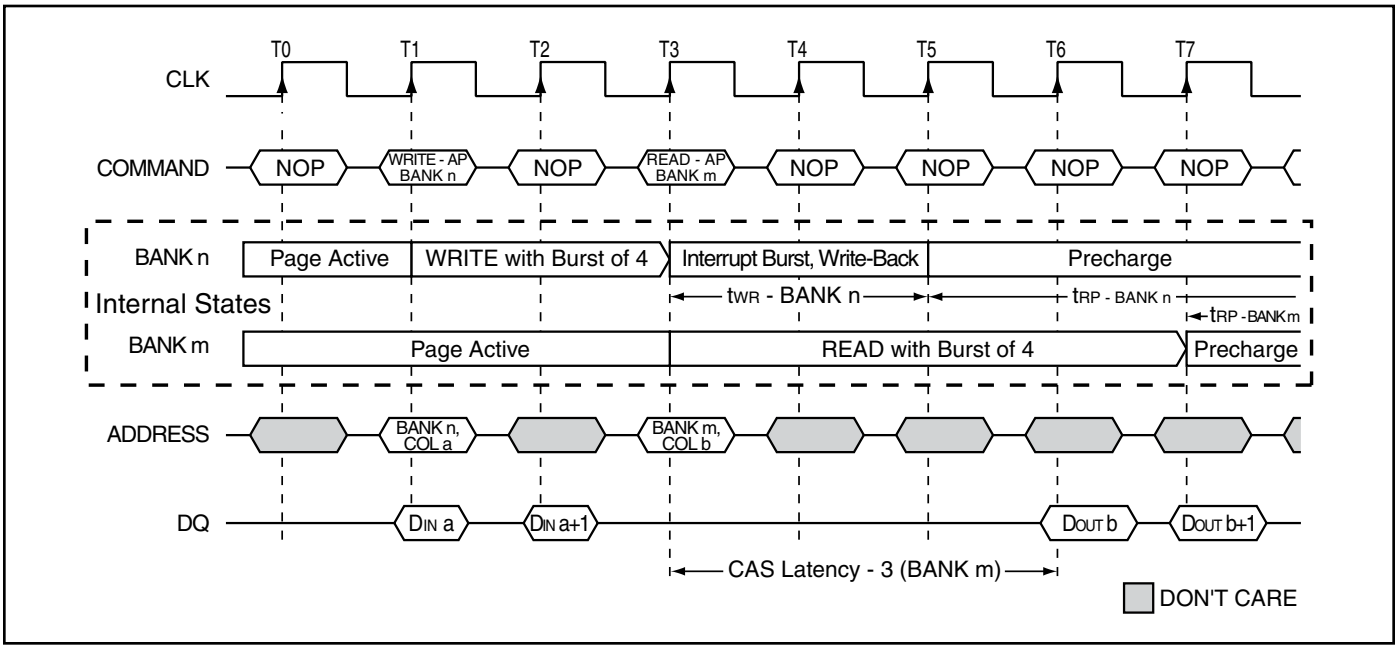
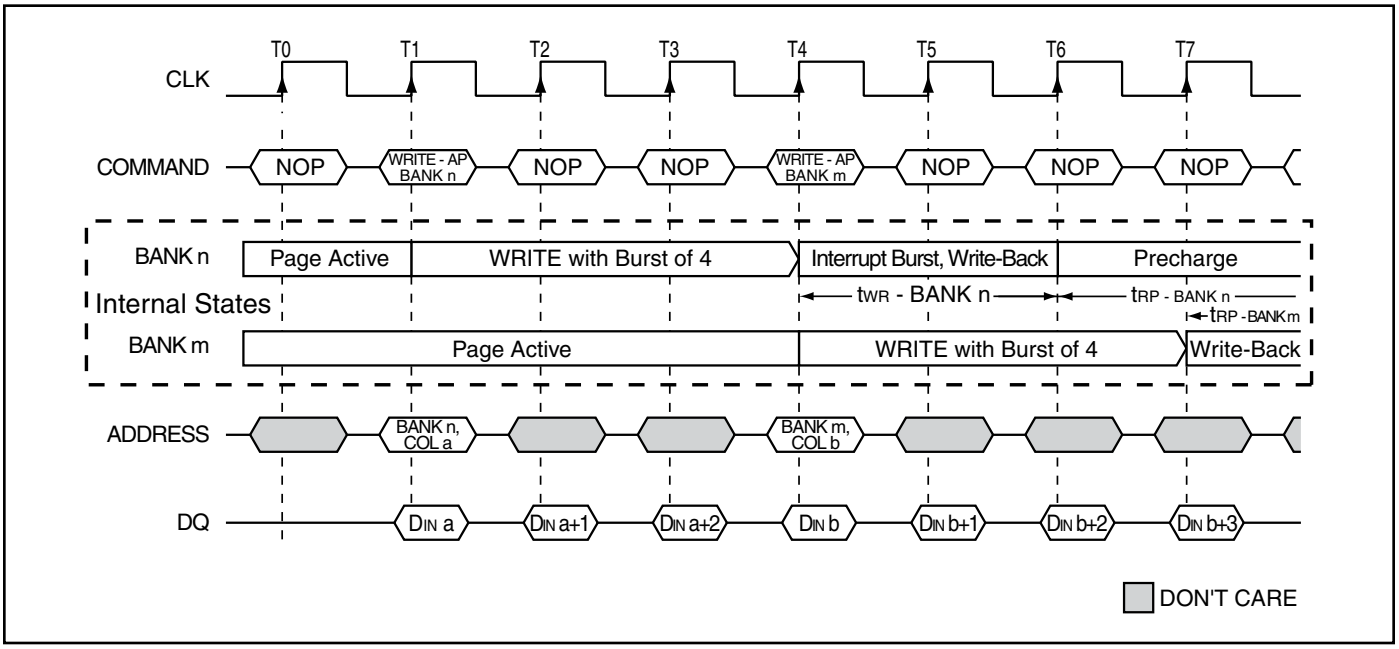


Fig CAP 4 - WRITE With Auto Precharge interrupted by a WRITE



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ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Parameters		Rating	Unit
$V_{DD\ MAX}$	Maximum Supply Voltage		–1.0 to +4.6	V
$V_{DDQ\ MAX}$	Maximum Supply Voltage for Output Buffer		–1.0 to +4.6	V
V_{IN}	Input Voltage		–1.0 to +4.6	V
V_{OUT}	Output Voltage		–1.0 to +4.6	V
$P_{D\ MAX}$	Allowable Power Dissipation		1	W
I_{CS}	Output Shorted Current		50	mA
T_{OPR}	Operating Temperature	Com. Ind. A1: A2:	0 to +70 –40 to +85 –40 to +85 –40 to +105	°C
T_{STG}	Storage Temperature		–55 to +150	°C

DC RECOMMENDED OPERATING CONDITIONS(2,5)

(T_A = 0°C to +70°C for Com. grade. T_A = -40°C to +85°C for Ind. and A1 grade, T_A = -40°C to +105°C for A2 grade)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{DD}, V_{DDQ}	Supply Voltage	3.0	3.3	3.6	V
V_{IH}	Input High Voltage(3)	2.0	—	V_{DD} + 0.3	V
V_{IL}	Input Low Voltage(4)	-0.3	—	+0.8	V

CAPACITANCE CHARACTERISTICS(2, 6) (At T_A = 0 to +25°C, V_{DD} = V_{DDQ} = 3.3 ± 0.3V, f = 1 MHz)

Symbol	Parameter	Typ.	Max.	Unit
C_{IN1}	Input Capacitance: (CLK)	—	4	pF
C_{IN2}	Input Capacitance: (All other input only pins)	—	4	pF
CI/O	Data Input/Output Capacitance: DQ0-DQ31	—	6	pF

Notes:

1. Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2. All voltages are referenced to GND.
3. V_{IH} (max) = V_{DDQ} + 1.2V with a pulse width ≤ 3 ns. The pluse width cannot be greater than one third of the cycle rate.
4. V_{IL} (min) = GND – 1.2V with a pulse < 3 ns. The pluse width cannot be greater than one third of the cycle rate.
5. An initial pause of 100us is required after power up, followed by two AUTO REFRESH commands, before proper device operation is ensured. (Vdd and VddQ must be powered up simultaneously. GND and GNDQ must be at same potential.) The two AUTO REFRESH command wake-ups should be repeated anytime the t_{REF} refresh requirement is exceeded.
6. The parameter is characterized.

THERMAL RESISTANCE

Package	Substrate	Theta-ja (Airflow = 0m/s)	Theta-ja (Airflow = 1m/s)	Theta-ja (Airflow = 2m/s)	Theta-jc	Units
TSOP2(86)	4-layer	85.4	78.4	74.4	15.0	C/W
BGA(90)	4-layer	47.0	41.7	39.0	8.6	C/W

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DC ELECTRICAL CHARACTERISTICS 1 (Recommended Operation Conditions unless otherwise noted.)

Symbol	Parameter	Test Condition	-5	-6	-7	Unit
I_{DD1} (1)	Operating Current	One bank active, CL = 3, BL = 1, t_{CLK} = t_{CLK} (min), t_{RC} = t_{RC} (min)	80	70	65	mA
I_{DD2P}	Precharge Standby Current (In Power-Down Mode)	CKE ≤ V_{IL} (MAX), t_{CK} = 15ns	2	2	2	mA
I_{DD2PS}	Precharge Standby Current (In Power-Down Mode)	CKE ≤ V_{IL} (MAX), CLK ≤ V_{IL} (MAX)	2	2	2	mA
I_{DD2N} (2)	Precharge Standby Current (In Non Power-Down Mode)	$\overline{CS}$ ≥ V_{DD} - 0.2V, CKE ≥ V_{IH} (MIN) t_{CK} = 15ns	16	16	16	mA
I_{DD2NS}	Precharge Standby Current (In Non Power-Down Mode)	$\overline{CS}$ ≥ V_{DD} - 0.2V, CKE ≥ V_{IH} (MIN) or CKE ≤ V_{IL} (MAX), All inputs stable	10	10	10	mA
I_{DD3N} (2)	Active Standby Current (In Non Power-Down Mode)	$\overline{CS}$ ≥ V_{DD} - 0.2V, CKE ≥ V_{IH} (MIN) t_{CK} = 15ns	22	22	22	mA
I_{DD3NS}	Active Standby Current (In Non Power-Down Mode)	$\overline{CS}$ ≥ V_{DD} - 0.2V, CKE ≥ V_{IH} (MIN) or CKE ≤ V_{IL} (MAX), All inputs stable	15	15	15	mA
I_{DD3P}	Active Standby Current (Power-Down Mode)	CKE ≤ V_{IL} (MAX), t_{CK} = 15ns	6	6	6	mA
I_{DD3PS}	Active Standby Current (Power-Down Mode)	CKE ≤ V_{IL} (MAX), CLK ≤ V_{IL} (MAX)	6	6	6	mA
I_{DD4}	Operating Current	All banks active, BL = 4, CL = 3, t_{CK} = t_{CK} (min)	110	100	90	mA
I_{DD5}	Auto-Refresh Current	t_{RC} = t_{RC} (min), t_{CLK} = t_{CLK} (min)	100	90	85	mA
I_{DD6}	Self-Refresh Current	CKE ≤ 0.2V	2	2	2	mA

Notes:

1. I_{DD} (MAX) is specified at the output open condition.
2. Input signals are changed one time during 30ns.

DC ELECTRICAL CHARACTERISTICS 2 (Recommended Operation Conditions unless otherwise noted.)

Symbol	Parameter	Test Condition	Min	Max	Unit
I_{IL}	Input Leakage Current	0V ≤ Vin ≤ V_{DD}, with pins other than the tested pin at 0V	-5	5	µA
I_{OL}	Output Leakage Current	Output is disabled, 0V ≤ Vout ≤ V_{DD},	-5	5	µA
V_{OH}	Output High Voltage Level	I_{OH} = -2mA	2.4	—	V
V_{OL}	Output Low Voltage Level	I_{OL} = 2mA	—	0.4	V

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AC ELECTRICAL CHARACTERISTICS (1,2,3)

			-5		-6		-7		
Symbol	Parameter	Condition	Min.	Max.	Min.	Max.	Min.	Max.	Units
t_{CK3}	Clock Cycle Time	$\overline{CAS}$ Latency = 3	5	—	6	—	7	—	ns
t_{CK2}		$\overline{CAS}$ Latency = 2	7.5	—	7.5	—	7.5	—	ns
t_{AC3}	Access Time From CLK(4)	$\overline{CAS}$ Latency = 3	—	4.8	—	5.4	—	5.4	ns
t_{AC2}		$\overline{CAS}$ Latency = 2	—	5.4	—	5.4	—	5.4	ns
t_{CH}	CLK HIGH Level Width		2	—	2.5	—	2.5	—	ns
t_{CL}	CLK LOW Level Width		2	—	2.5	—	2.5	—	ns
t_{OH3}	Output Data Hold Time	$\overline{CAS}$ Latency = 3	2.2	—	2.5	—	2.5	—	ns
t_{OH2}	Output Data Hold Time	$\overline{CAS}$ Latency = 2	2.5	—	2.5	—	2.5	—	ns
t_{LZ}	Output LOW Impedance Time		0	—	0	—	0	—	ns
t_{HZ3}	Output HIGH Impedance Time(5)	$\overline{CAS}$ Latency = 3	—	4.8	—	5.4	—	5.4	ns
t_{HZ2}		$\overline{CAS}$ Latency = 2	—	5.4	—	5.4	—	5.4	ns
t_{DS}	Input Data Setup Time		1.5	—	1.5	—	1.5	—	ns
t_{DH}	Input Data Hold Time		0.8	—	0.8	—	0.8	—	ns
t_{AS}	Address Setup Time		1.5	—	1.5	—	1.5	—	ns
t_{AH}	Address Hold Time		0.8	—	0.8	—	0.8	—	ns
t_{CKS}	CKE Setup Time		1.5	—	1.5	—	1.5	—	ns
t_{CKH}	CKE Hold Time		0.8	—	0.8	—	0.8	—	ns
t_{CKA}	CKE to CLK Recovery Delay Time		1CLK+3	—	1CLK+3	—	1CLK+3	—	ns
t_{CMS}	Command Setup Time ($\overline{CS}$, $\overline{RAS}$, $\overline{CAS}$, $\overline{WE}$, DQM)		1.5	—	1.5	—	1.5	—	ns
t_{CMH}	Command Hold Time ($\overline{CS}$, $\overline{RAS}$, $\overline{CAS}$, $\overline{WE}$, DQM)		0.8	—	0.8	—	0.8	—	ns
t_{RC}	Command Period (REF to REF / ACT to ACT)		55	—	60	—	70	—	ns
t_{RAS}	Command Period (ACT to PRE)		38.7	120K	42	120K	42	120K	ns
t_{RP}	Command Period (PRE to ACT)		15	—	18	—	20	—	ns
t_{RCD}	Active Command To Read / Write Command Delay Time		15	—	18	—	20	—	ns
t_{RRD}	Command Period (ACT [0] to ACT[1])		10	—	12	—	14	—	ns

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AC ELECTRICAL CHARACTERISTICS (1,2,3)

				-5		-6		-7		
Symbol	**Parameter**	**Condition**		**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
t_{DPL3}	Input Data To Precharge Command Delay time	CAS Latency = 3		2CLK	—	2CLK	—	2CLK	—	ns
t_{DPL2}		$\overline{CAS}$ Latency = 2		2CLK	—	2CLK	—	2CLK	—	ns
t_{DAL3}	Input Data To Active / Refresh Command Delay time (During Auto-Precharge)	$\overline{CAS}$ Latency = 3		2CLK+t_{RP}	—	2CLK+t_{RP}	—	2CLK+t_{RP}	—	ns
t_{DAL2}		$\overline{CAS}$ Latency = 2		2CLK+t_{RP}	—	2CLK+t_{RP}	—	2CLK+t_{RP}	—	ns
t_T	Transition Time(2)			0.3	1.2	0.3	1.2	0.3	1.2	ns
t_{WR}	Write Recovery Time			1CLK+5ns	—	1CLK+6ns	—	1CLK+7ns	—	t_{CK}
t_{XSR}	Exit Self Refresh to Active Time(6)			60	—	66	—	77	—	ns
t_{REF}	Refresh Cycle Time (4096)	$T_A \leq 70^oC$	Com, Ind, A1, A2	—	64	—	64	—	64	ms
		$T_A \leq 85^oC$	Ind,A1,A2	—	—	—	64	—	64	ms
		$T_A > 85^oC$	A2	—	—	—	16	—	16	ms

Notes:

1. An initial pause of 100us is required after power up, followed by two AUTO REFRESH commands, before proper device operation is ensured. (V_{DD} and V_{DDQ} must be powered up simultaneously. GND and GNDQ must be at same potential.) The two AUTO REFRESH command wake-ups should be repeated anytime the t_{REF} refresh requirement is exceeded.
2. Measured with t_T = 0.5 ns.
3. The reference level is 1.5V when measuring input signal timing. Rise/fall times are measured between V_{IH} (min.) and V_{IL} (max.).
4. Access time is measured at 1.5V with the load shown in the figure that follows.
5. The time t_{HZ} (max.) is defined as the time required for the output voltage to transition by ± 200 mV from V_{OH} (min.) or V_{OL} (max.) when the output is in the high impedance state.
6. CLK must be toggled a minimum of two times during this period.

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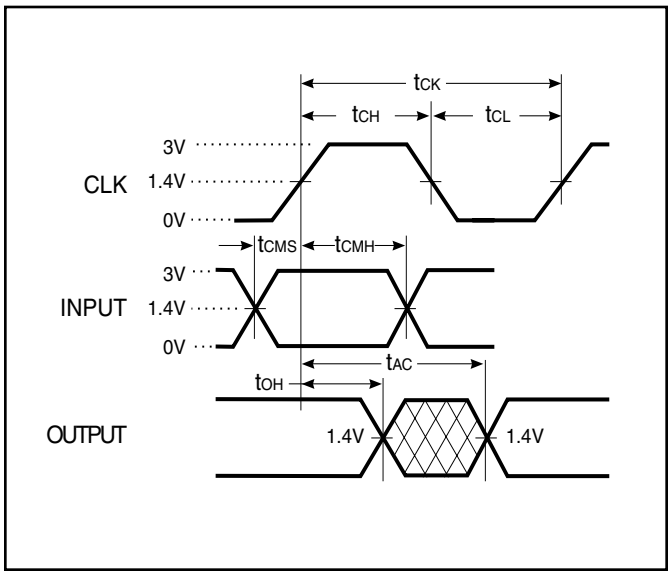
OPERATING FREQUENCY / LATENCY RELATIONSHIPS(1)

SYMBOL	PARAMETER	CONDITION	-5	-6	-7	UNITS
—	Clock Cycle Time		5	6	7	ns
—	Operating Frequency	CL=3	200[1]	166[1]	143[1]	MHz
t_{CCD}	READ/WRITE command to READ/WRITE command		1	1	1	cycle
t_{CKED}	CKE to clock disable or power-down entry mode		1	1	1	cycle
t_{PED}	CKE to clock enable or power-down exit setup mode		1	1	1	cycle
t_{DQD}	DQM to input data delay		0	0	0	cycle
t_{DQM}	DQM to data mask during WRITEs		0	0	0	cycle
t_{DQZ}	DQM to data high-impedance during READs		2	2	2	cycle
t_{DWD}	WRITE command to input data delay		0	0	0	cycle
t_{DAL}	Data-in to ACTIVE command	CL=3 CL=2	5 4	5 4	5 4	cycle
t_{DPL}	Data-in to PRECHARGE command		2	2	2	cycle
t_{BDL}	Last data-in to burst STOP command		1	1	1	cycle
t_{CDL}	Last data-in to new READ/WRITE command		1	1	1	cycle
t_{RDL}	Last data-in to PRECHARGE command		2	2	2	cycle
t_{MRD}	LOAD MODE REGISTER command to ACTIVE or REFRESH command		2	2	2	cycle
t_{ROH}	Data-out to high-impedance from PRECHARGE command	CL = 3 CL = 2	3 2	3 2	3 2	cycle

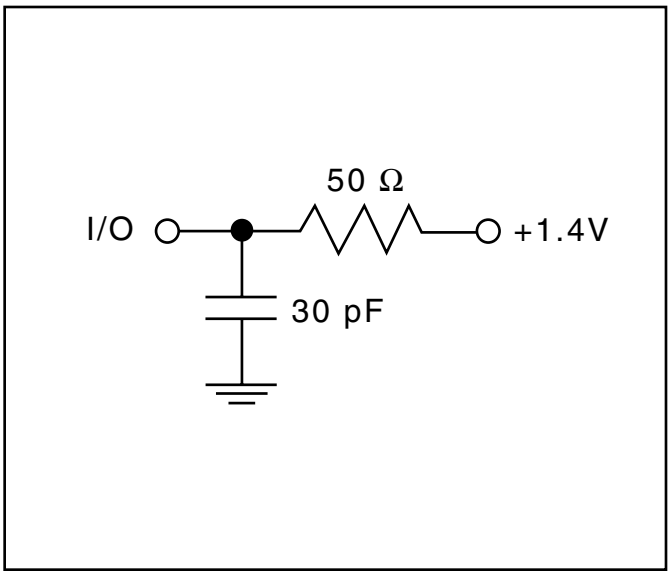
Note:
1. If CL = 2, the minimum t_{CK2} is 7.5.

AC TEST CONDITIONS (Input/Output Reference Level: 1.4V)

Input Load

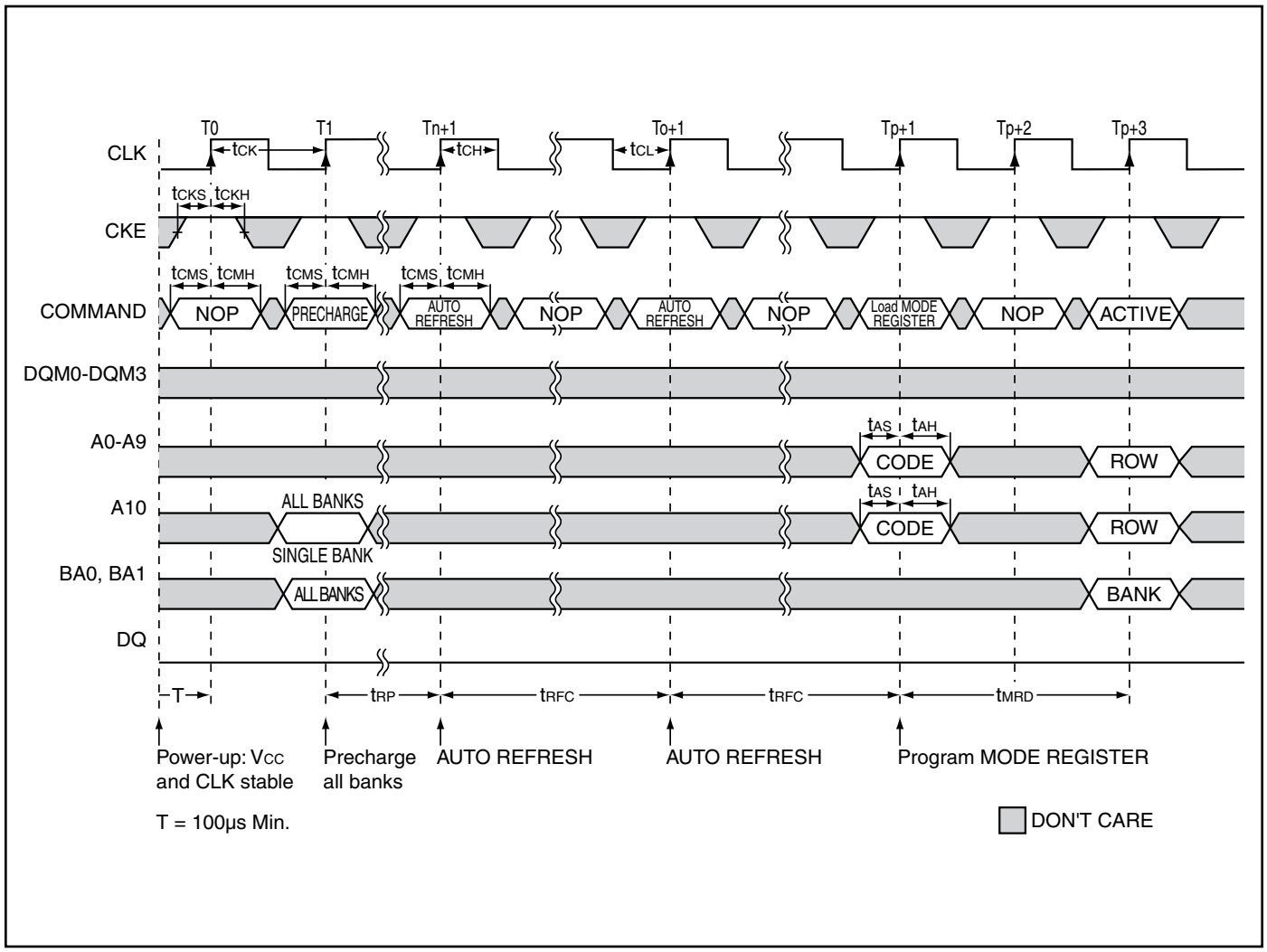


Output Load



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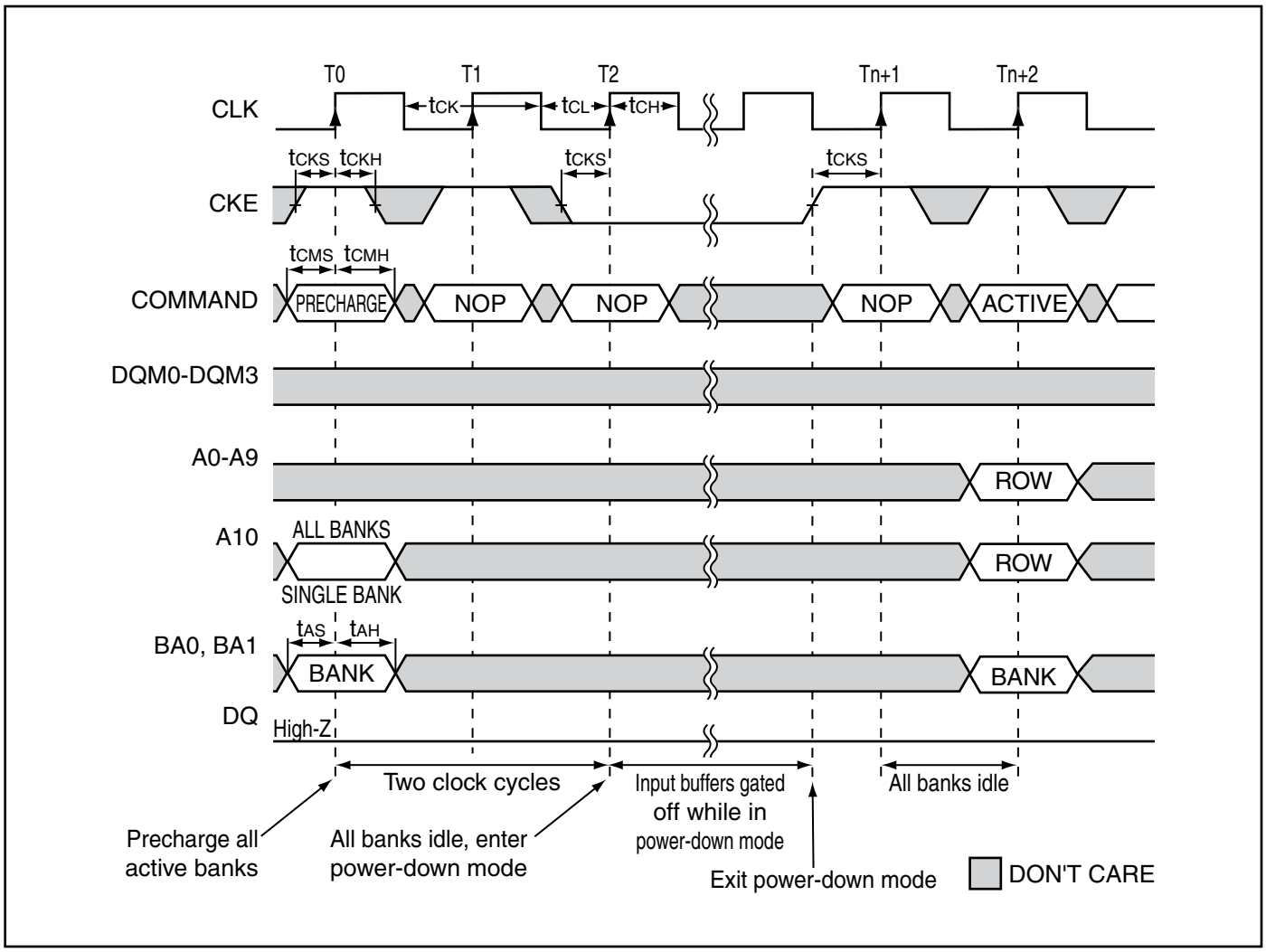
INITIALIZE AND LOAD MODE REGISTER(1)



Notes:
1. If $\overline{CS}$ is High at clock High time, all commands applied are NOP.
2. The Mode Register may be loaded prior to the Auto-Refresh cycles, if desired.
3. JEDEC and PC100 specify three clocks.
4. Outputs are guaranteed High-Z after the command is issued.

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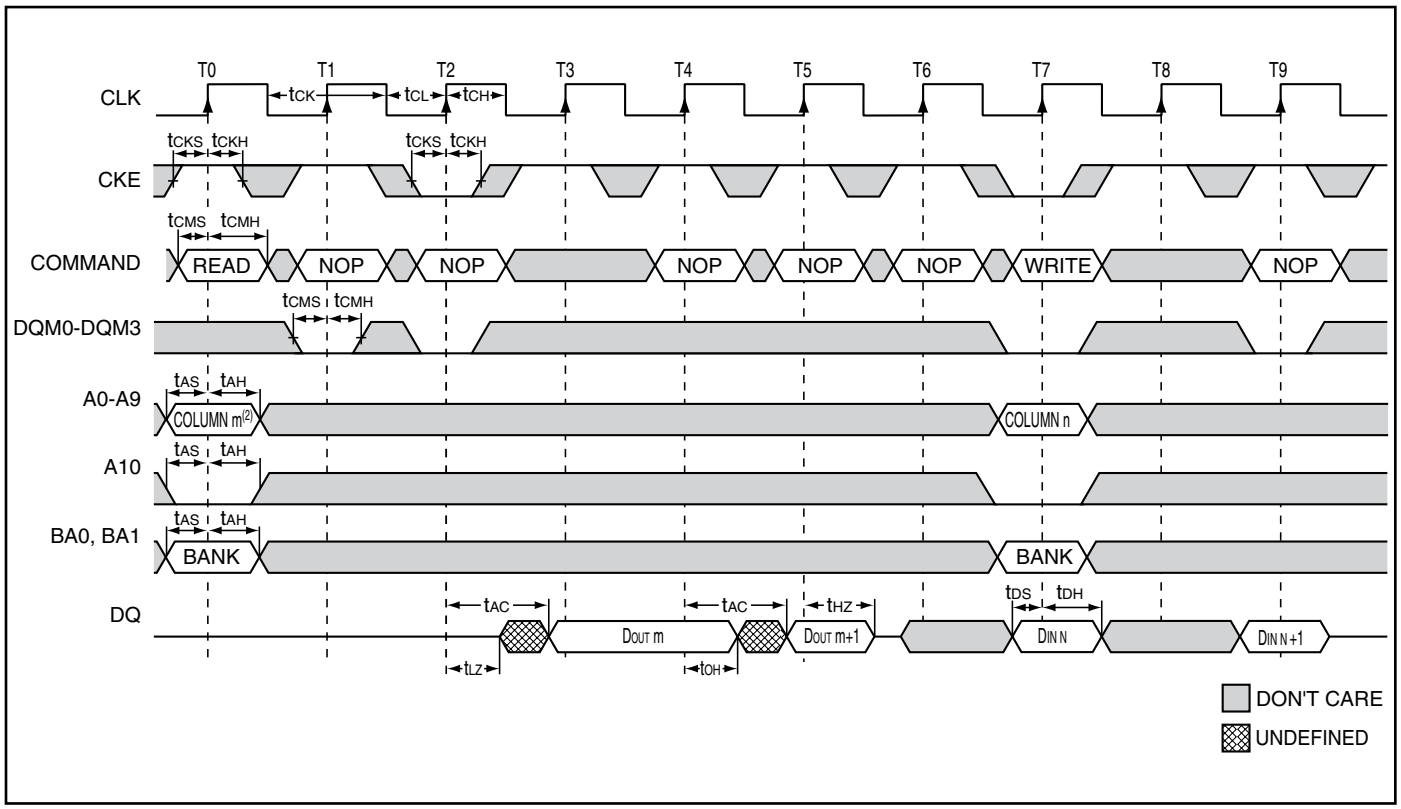
POWER-DOWN MODE CYCLE



$\overline{CAS}$ latency = 2, 3

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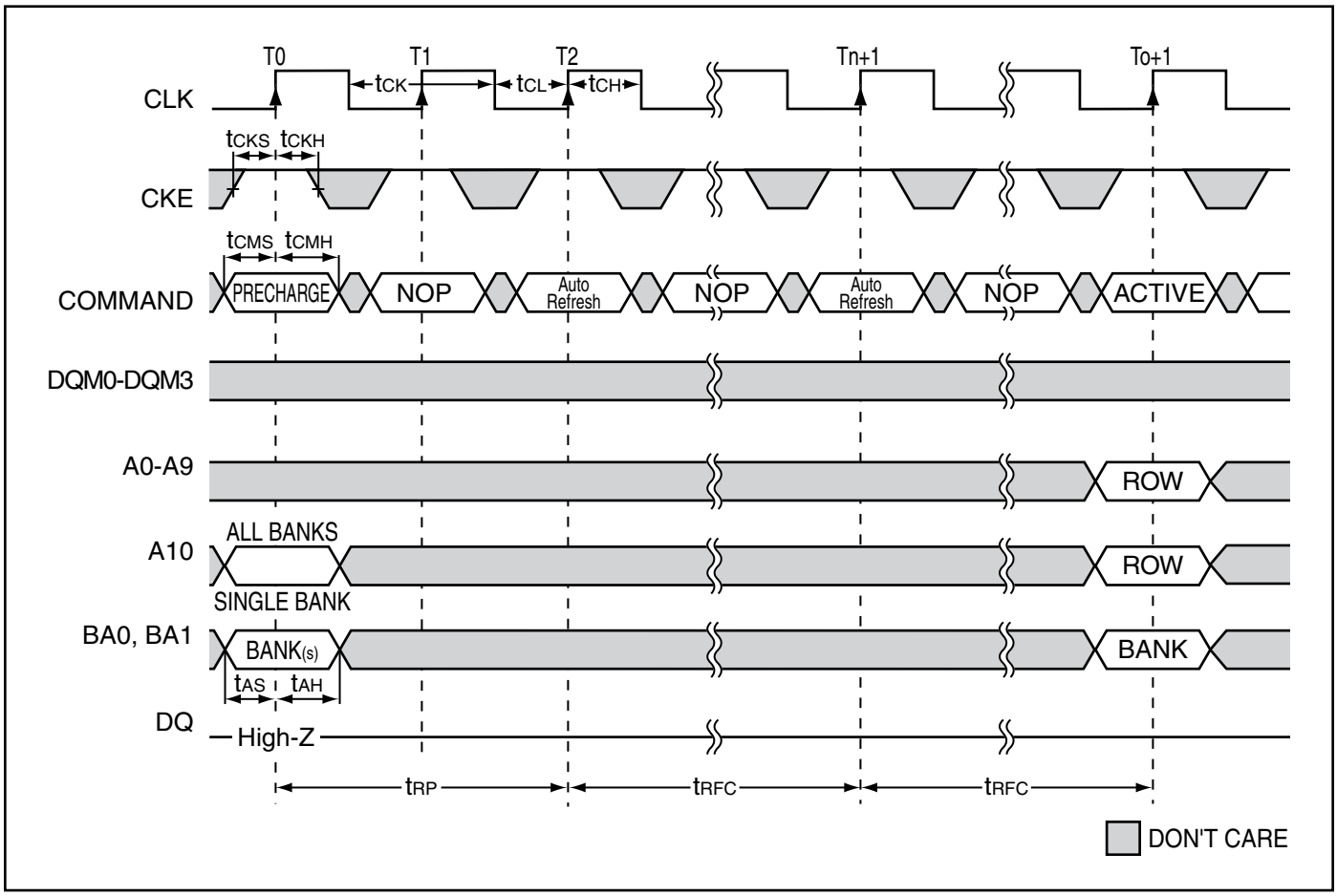
CLOCK SUSPEND MODE



$\overline{\text{CAS}}$ latency = 2, burst length = 2

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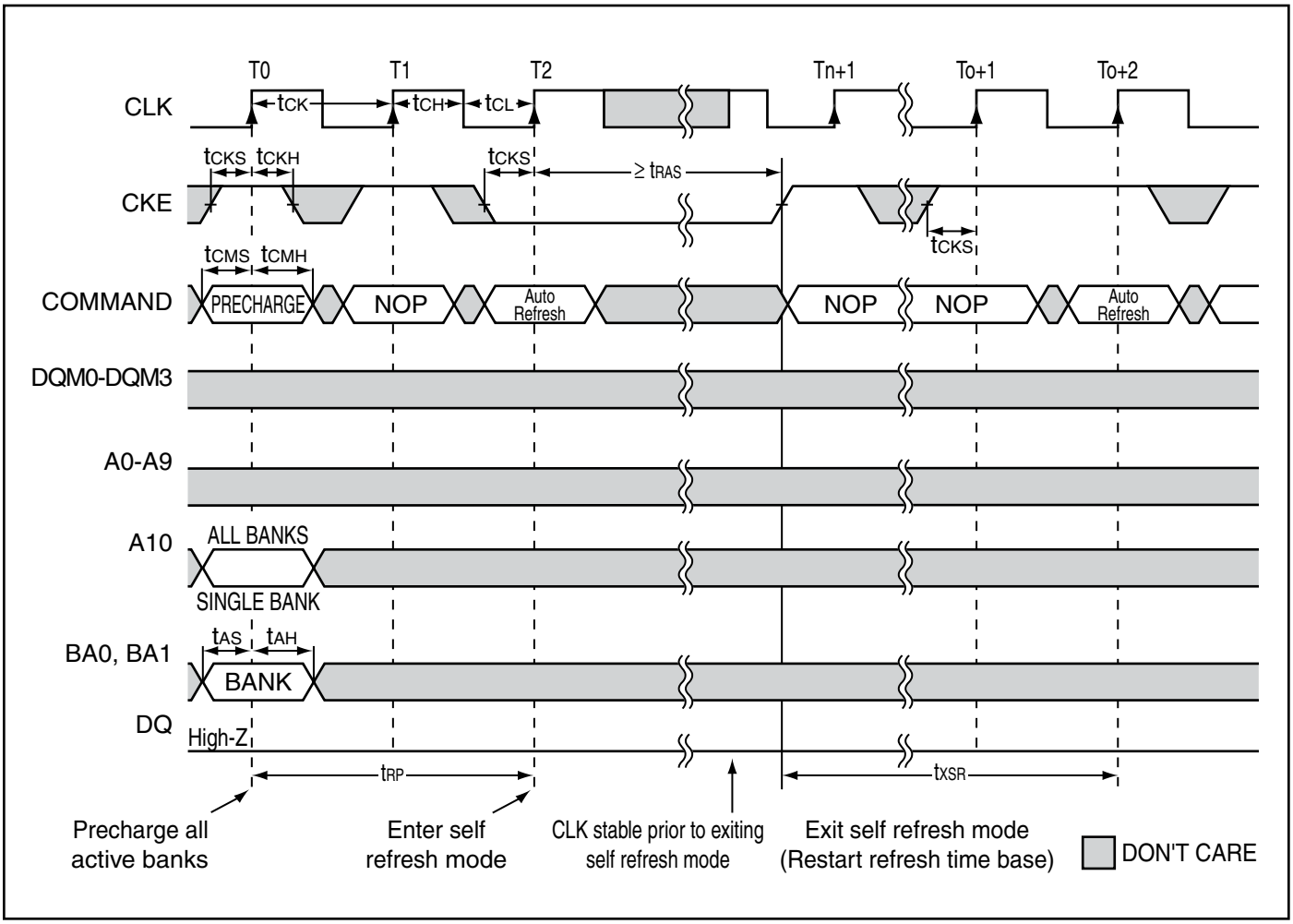
AUTO-REFRESH CYCLE



$\overline{\text{CAS}}$ latency = 2, 3

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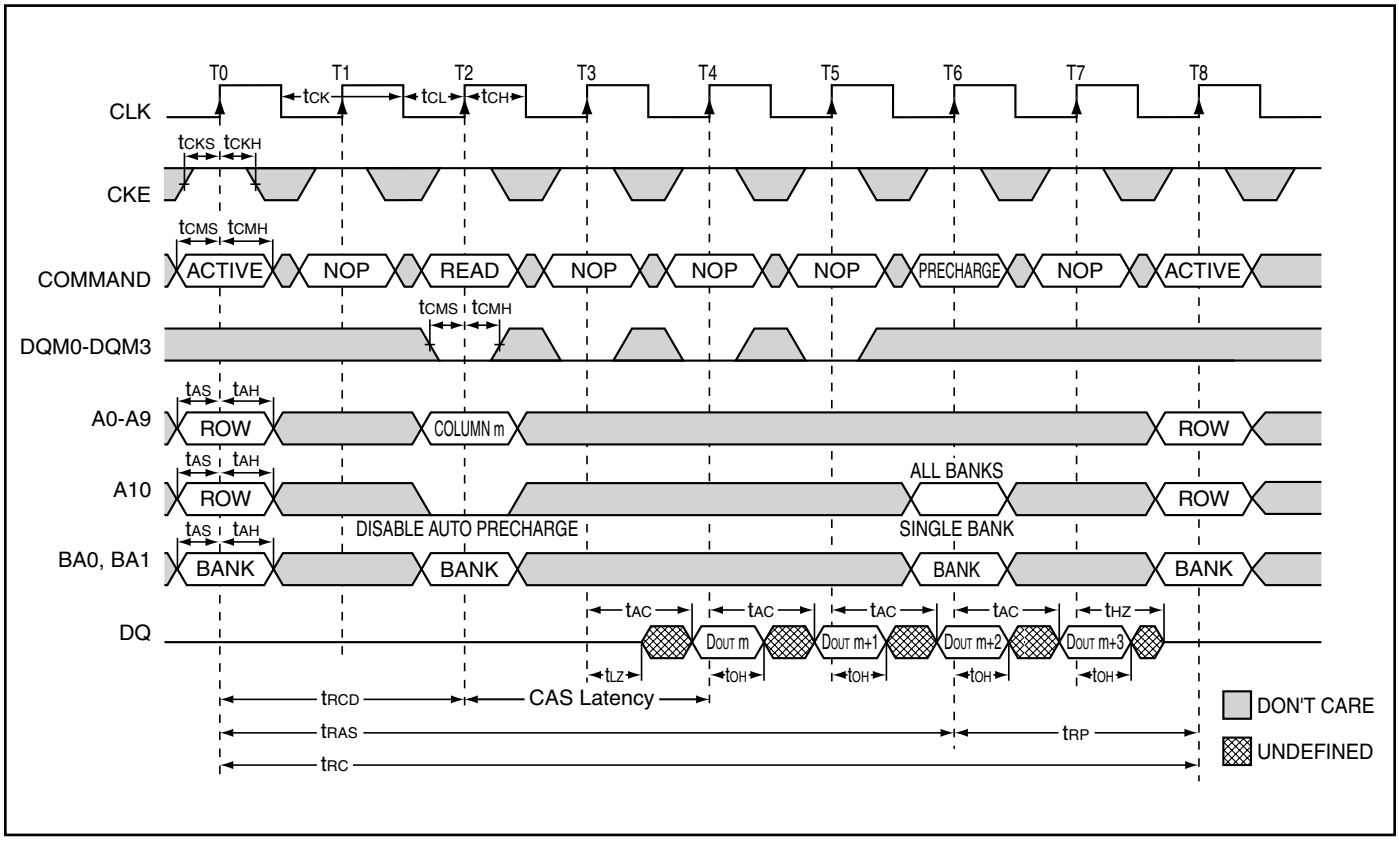
SELF-REFRESH CYCLE



Note:
1. Self-Refresh Mode is not supported for A2 grade with T_A > 85°C.

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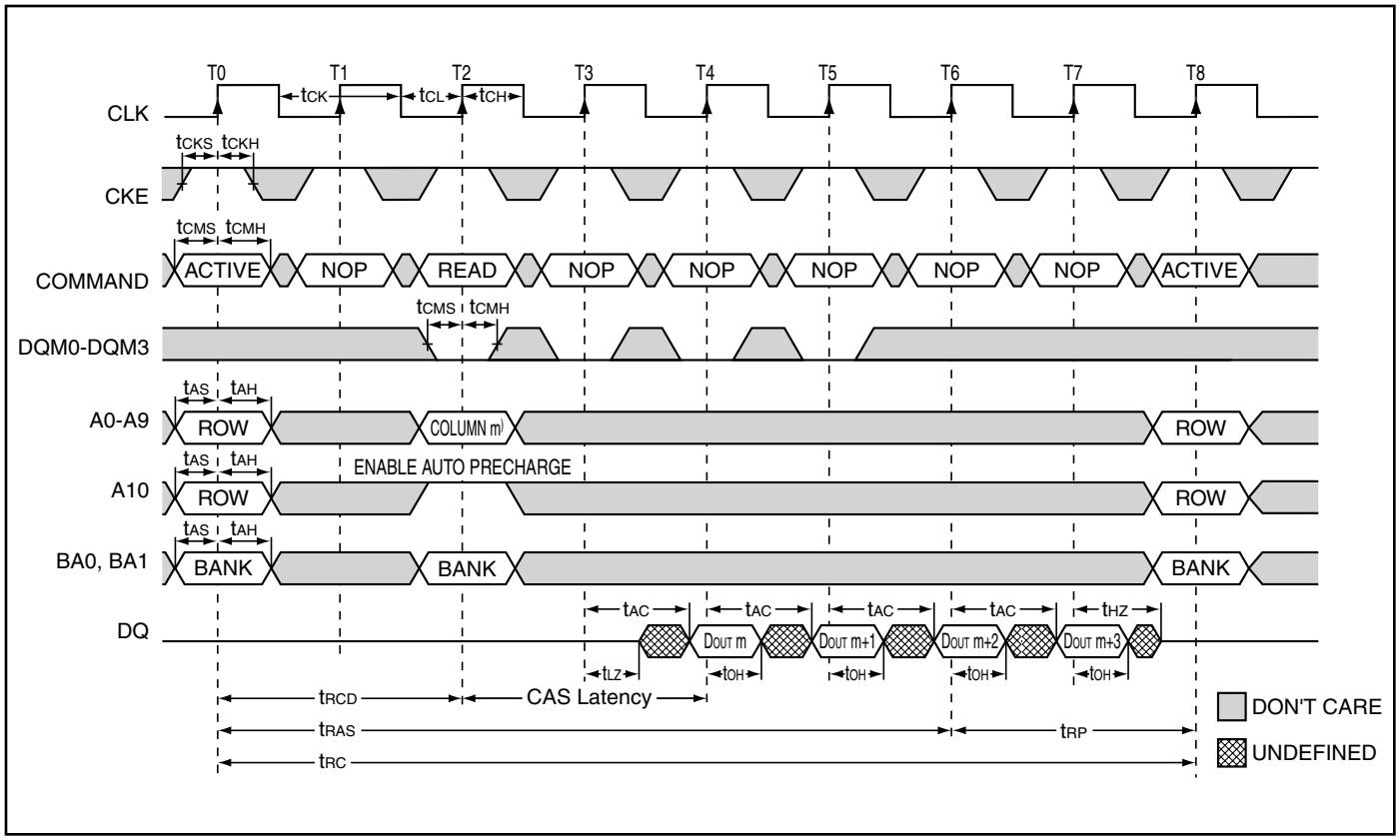
READ WITHOUT AUTO PRECHARGE



$\overline{\text{CAS}}$ latency = 2, Burst Length = 4

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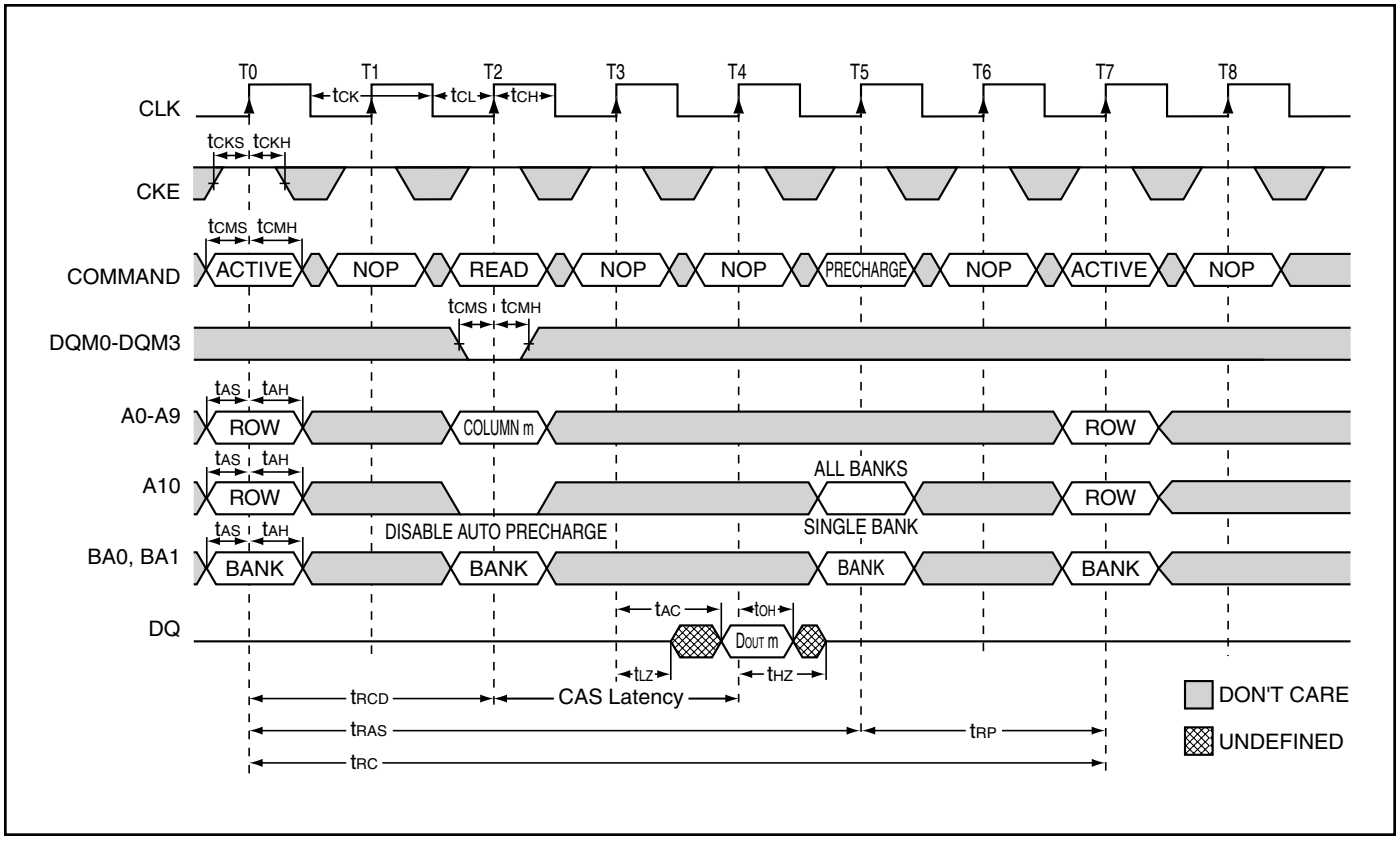
READ WITH AUTO PRECHARGE



$\overline{\text{CAS}}$ latency = 2, Burst Length = 4

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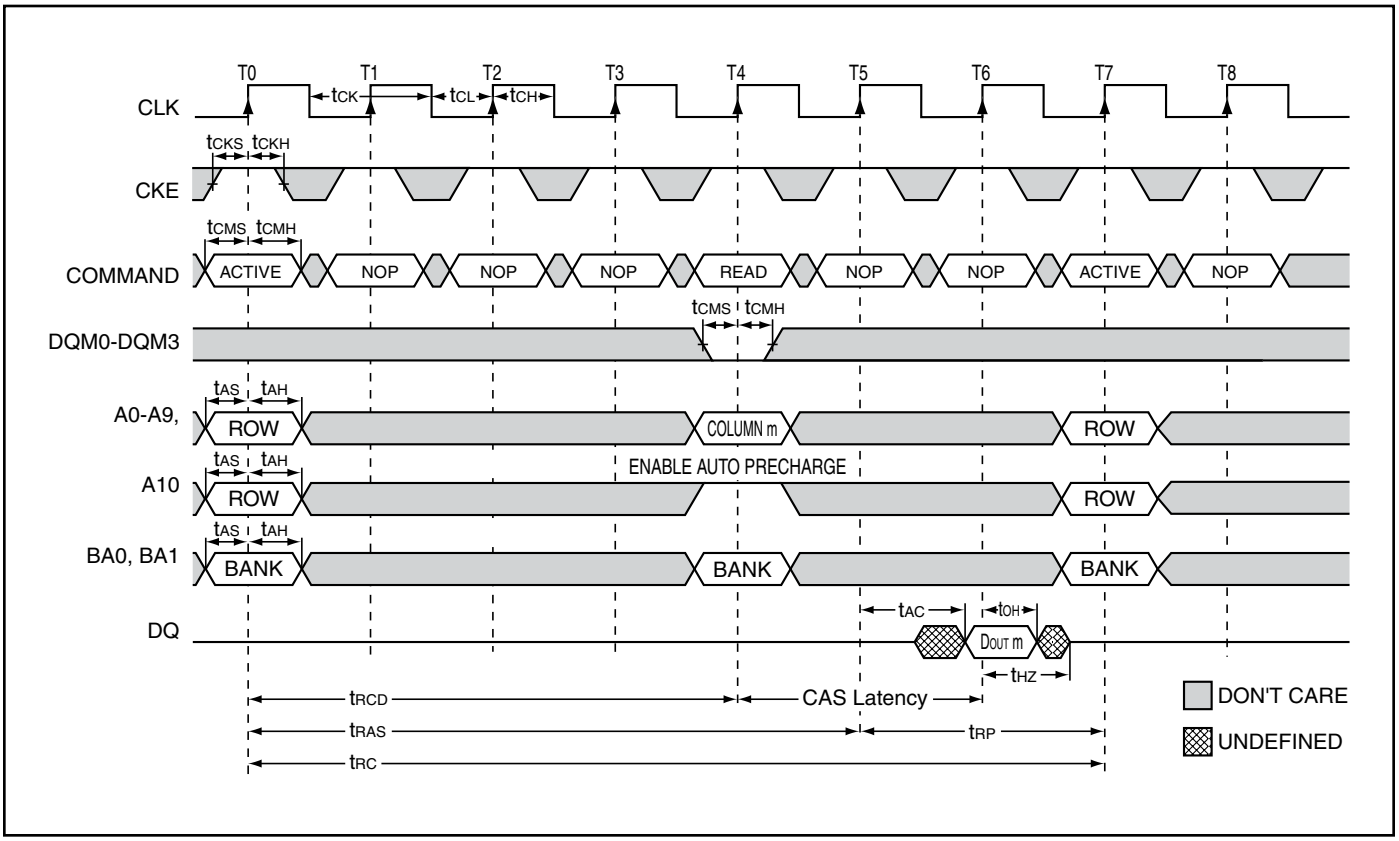
SINGLE READ WITHOUT AUTO PRECHARGE



$\overline{\text{CAS}}$ **latency = 2, Burst Length = 1**

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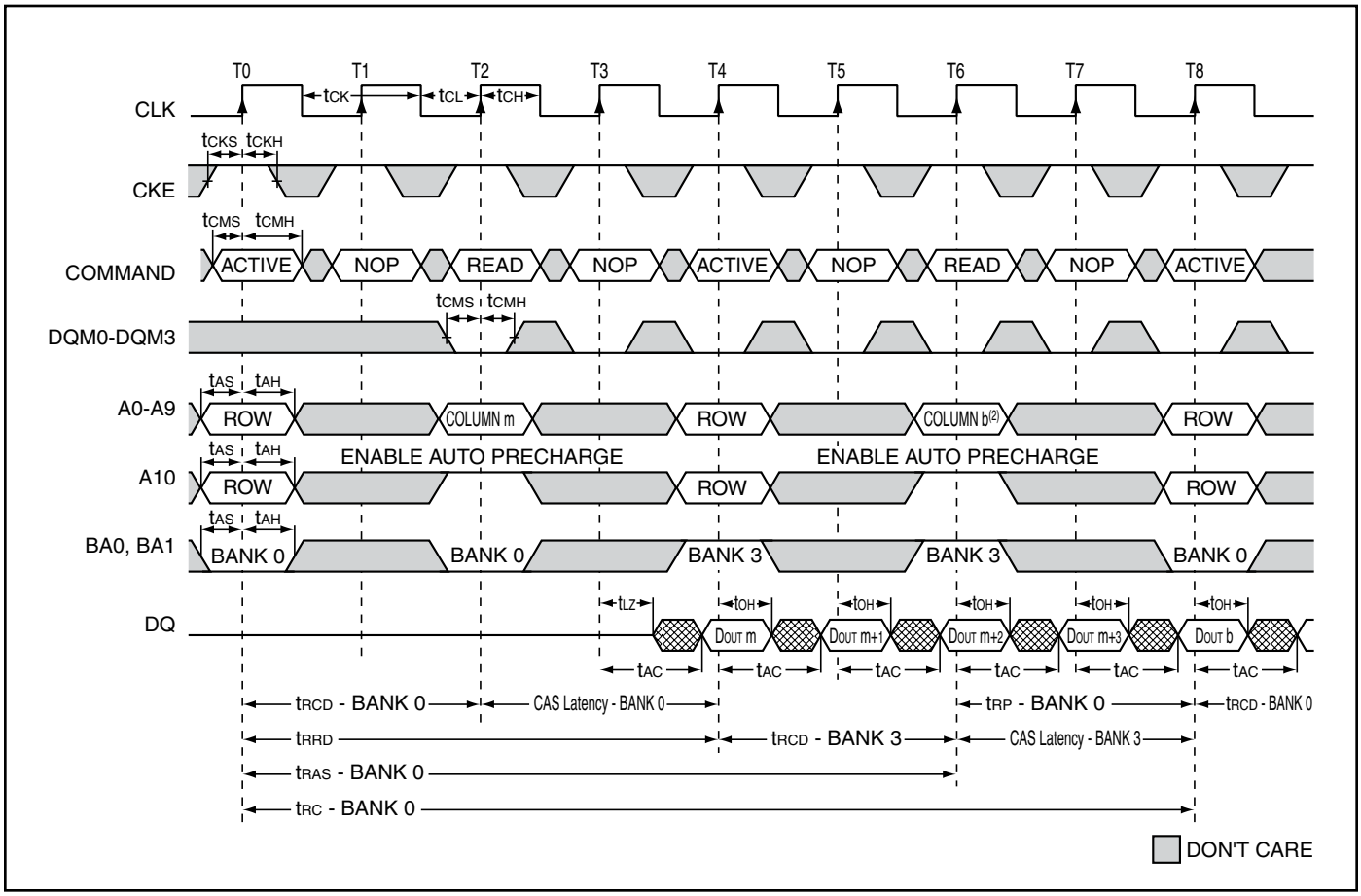
SINGLE READ WITH AUTO PRECHARGE



$\overline{\text{CAS}}$ latency = 2, Burst Length = 1

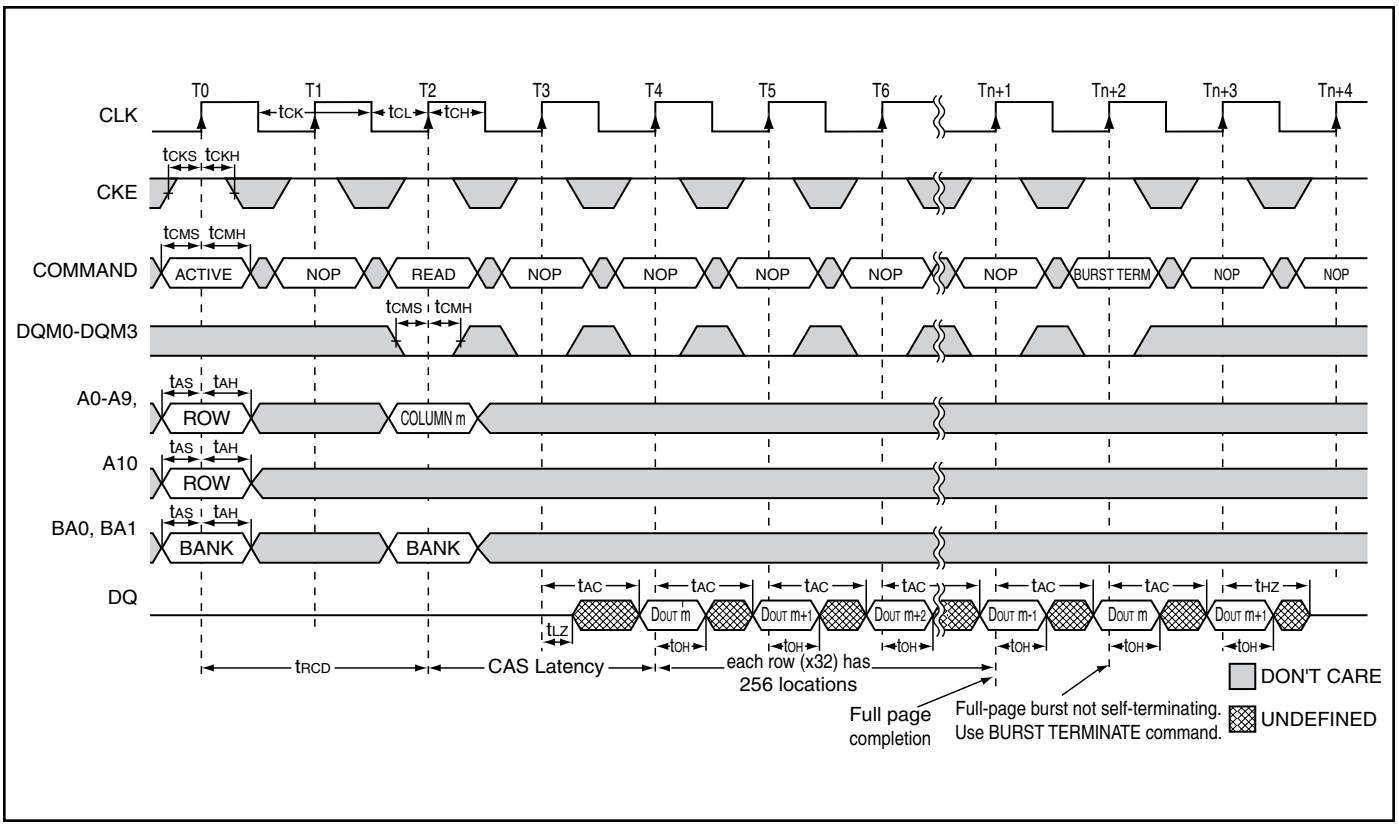
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ALTERNATING BANK READ ACCESSES



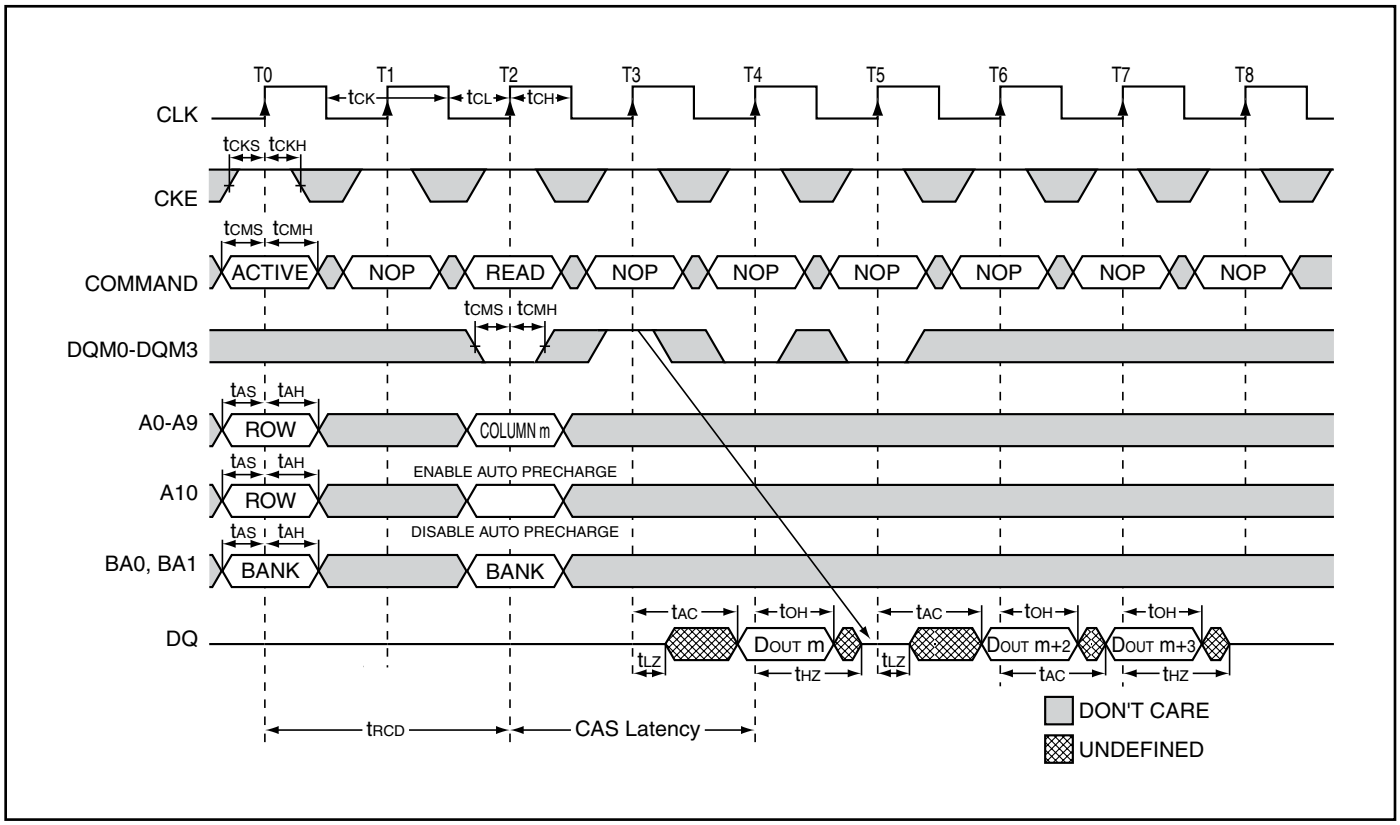
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READ - FULL-PAGE BURST



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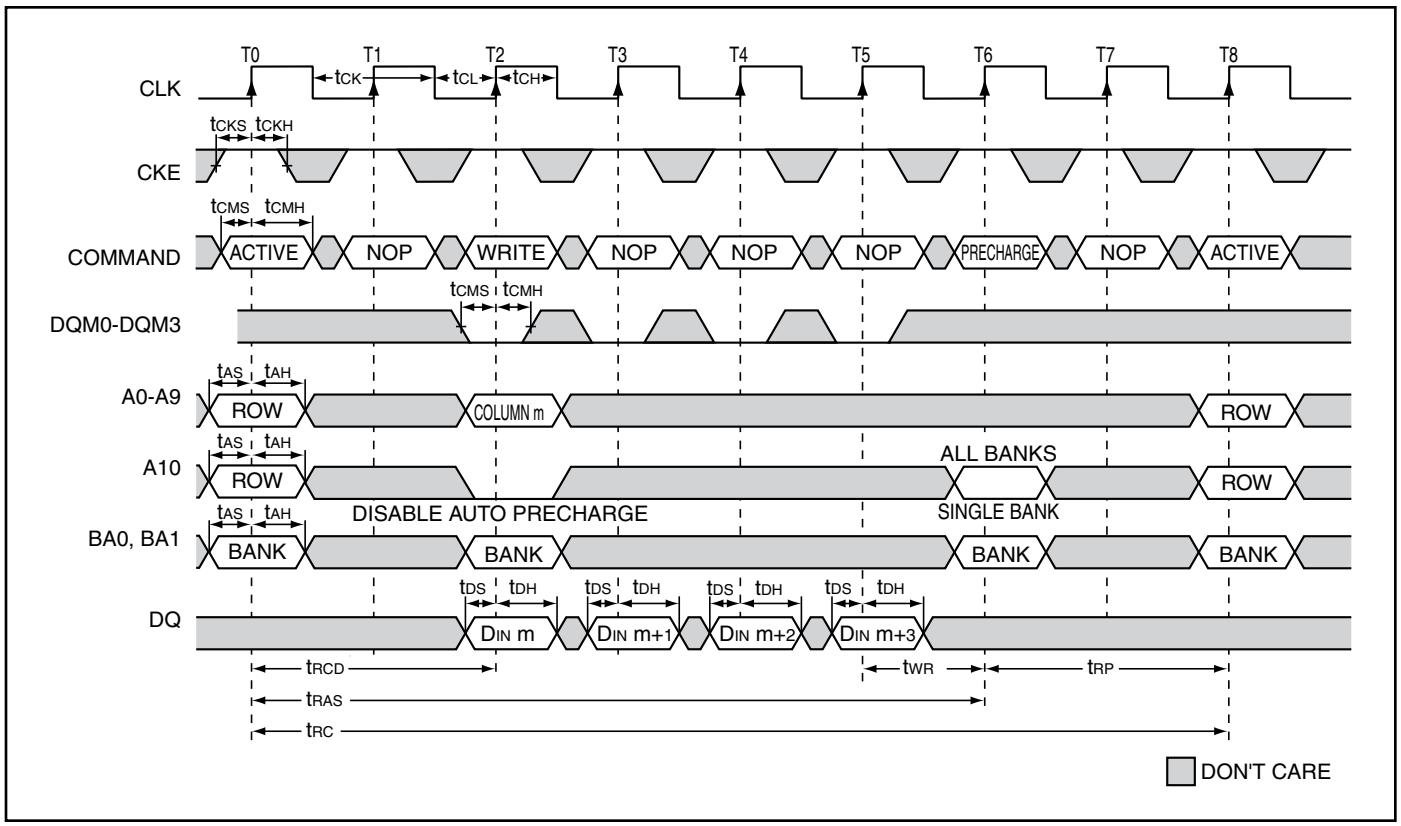
READ - DQM OPERATION



$\overline{\text{CAS}}$ Latency = 2, Burst Length = 4

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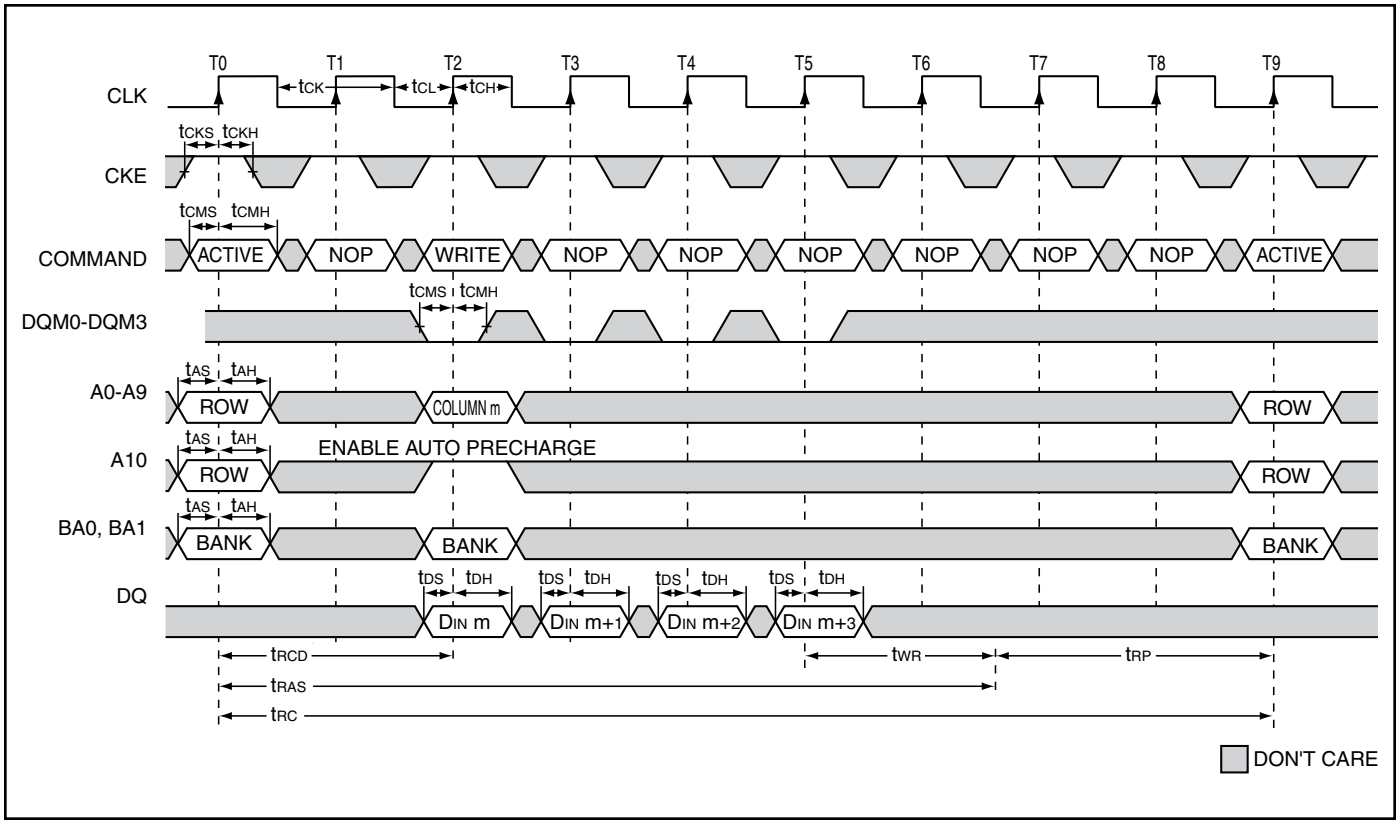
WRITE - WITHOUT AUTO PRECHARGE



Burst Length = 4

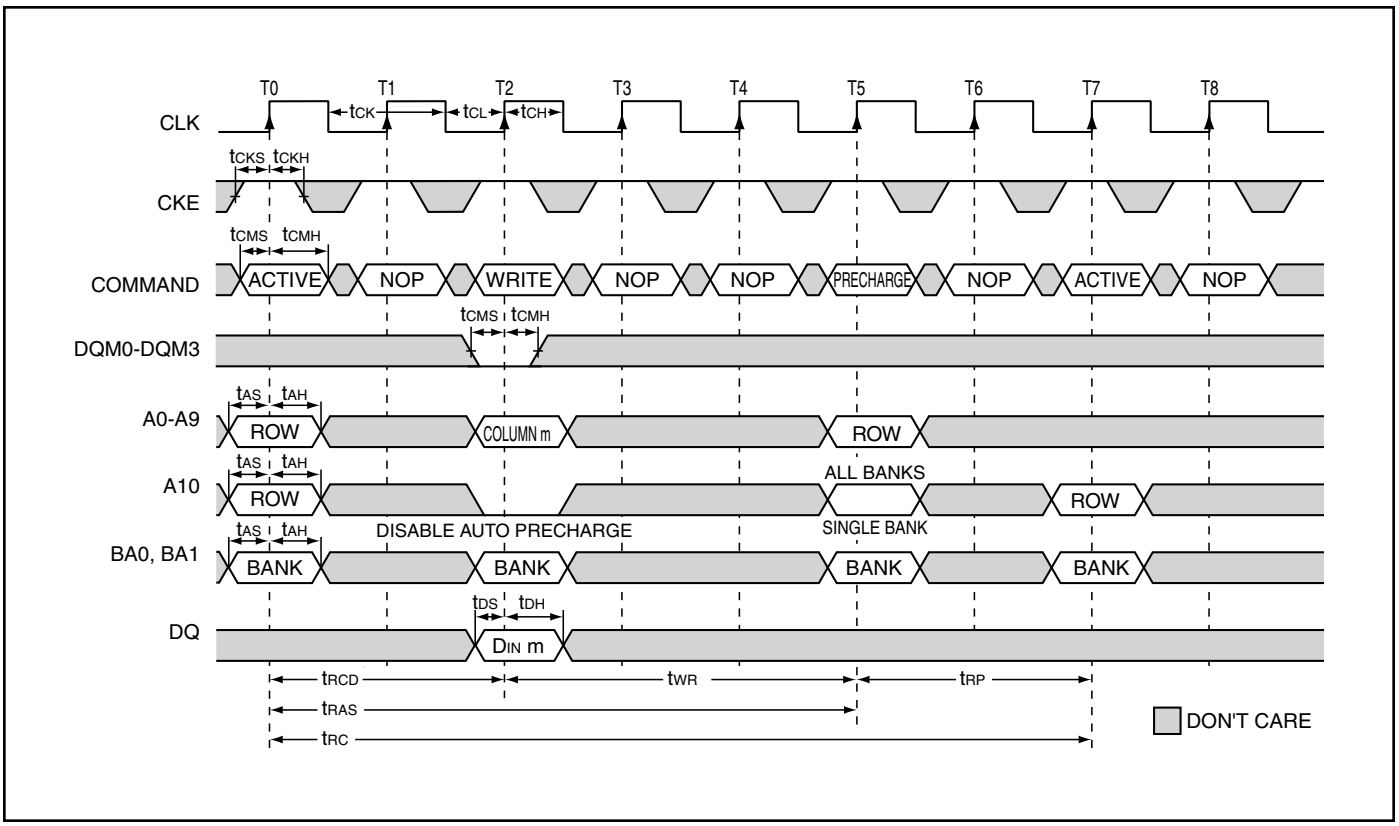
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WRITE - WITH AUTO PRECHARGE



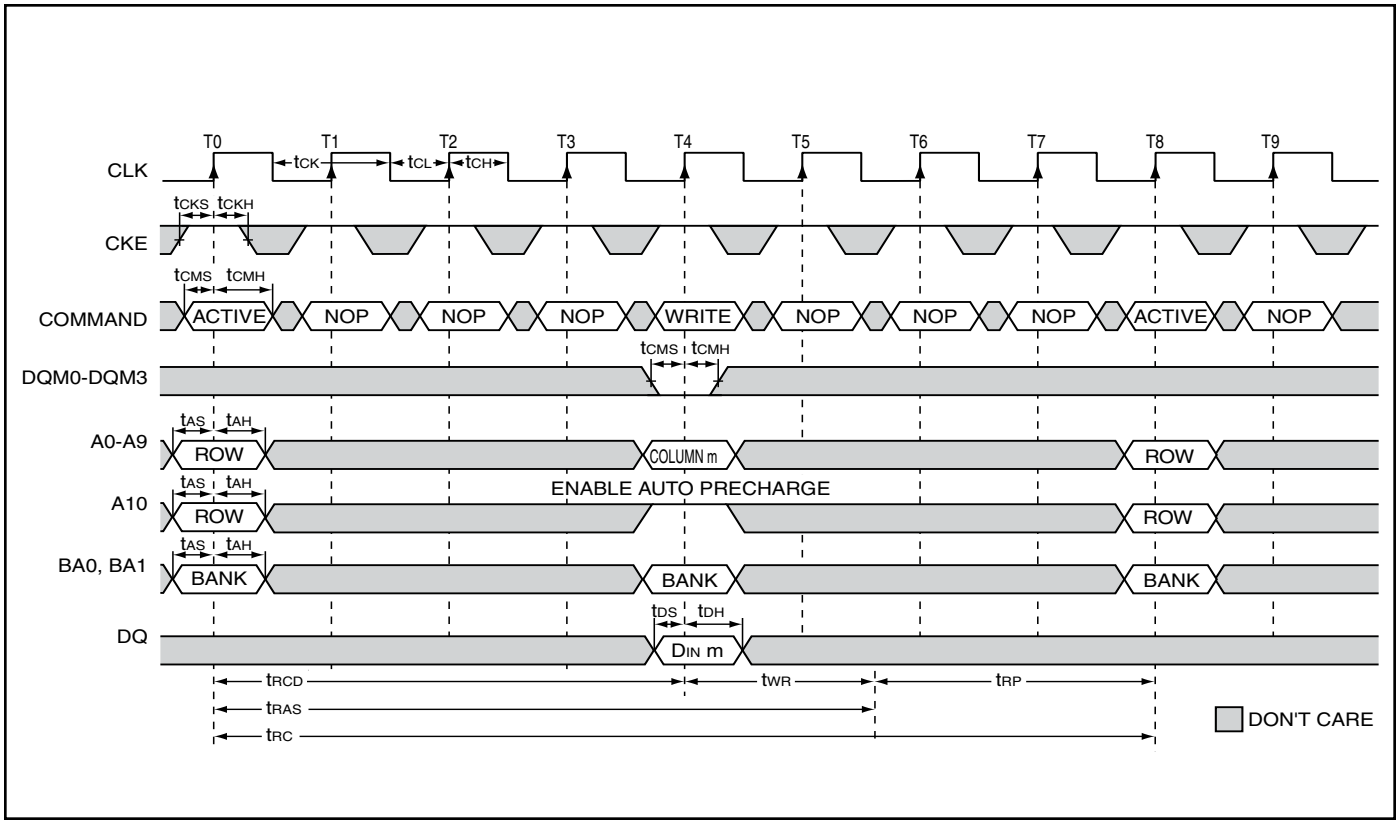
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SINGLE WRITE - WITHOUT AUTO PRECHARGE



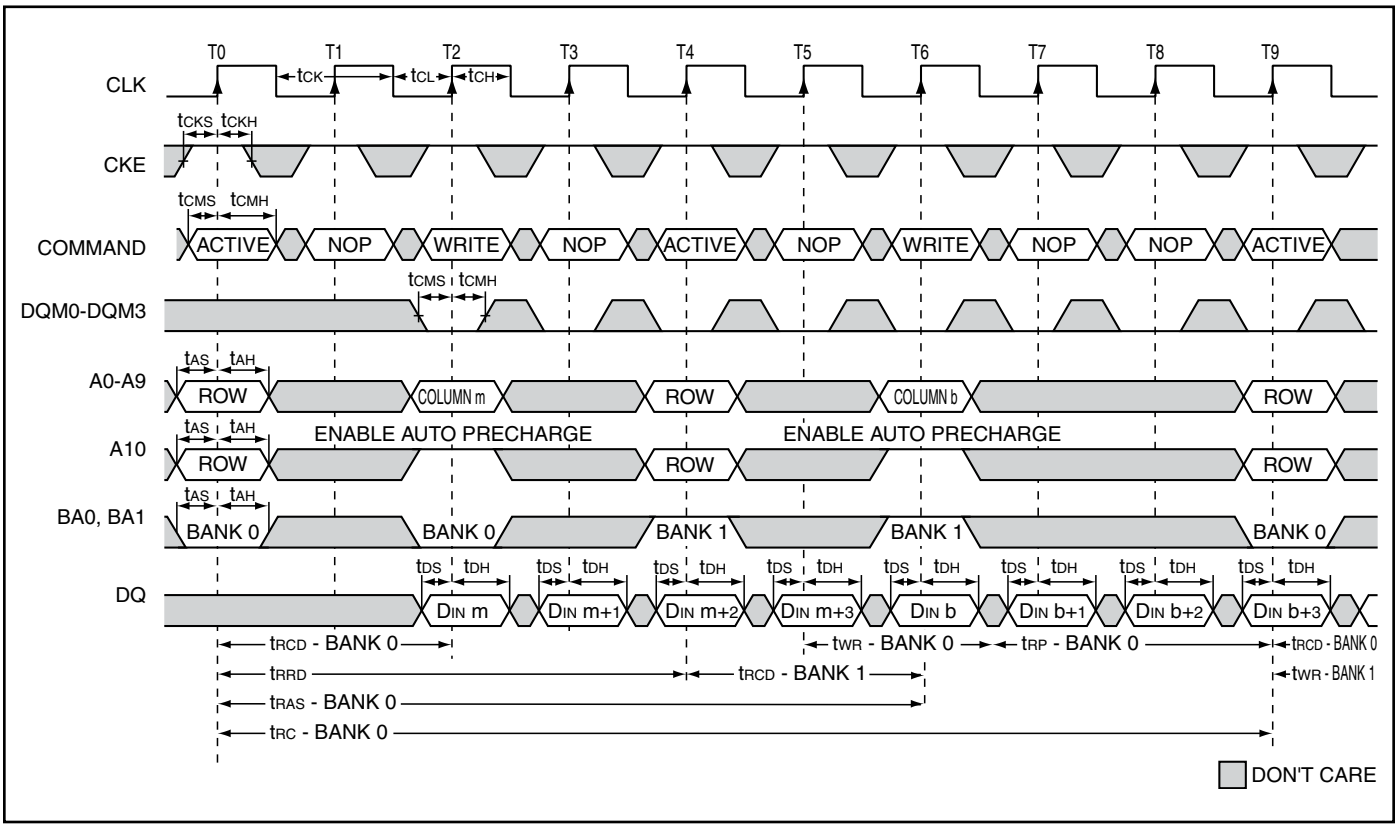
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SINGLE WRITE - WITH AUTO PRECHARGE



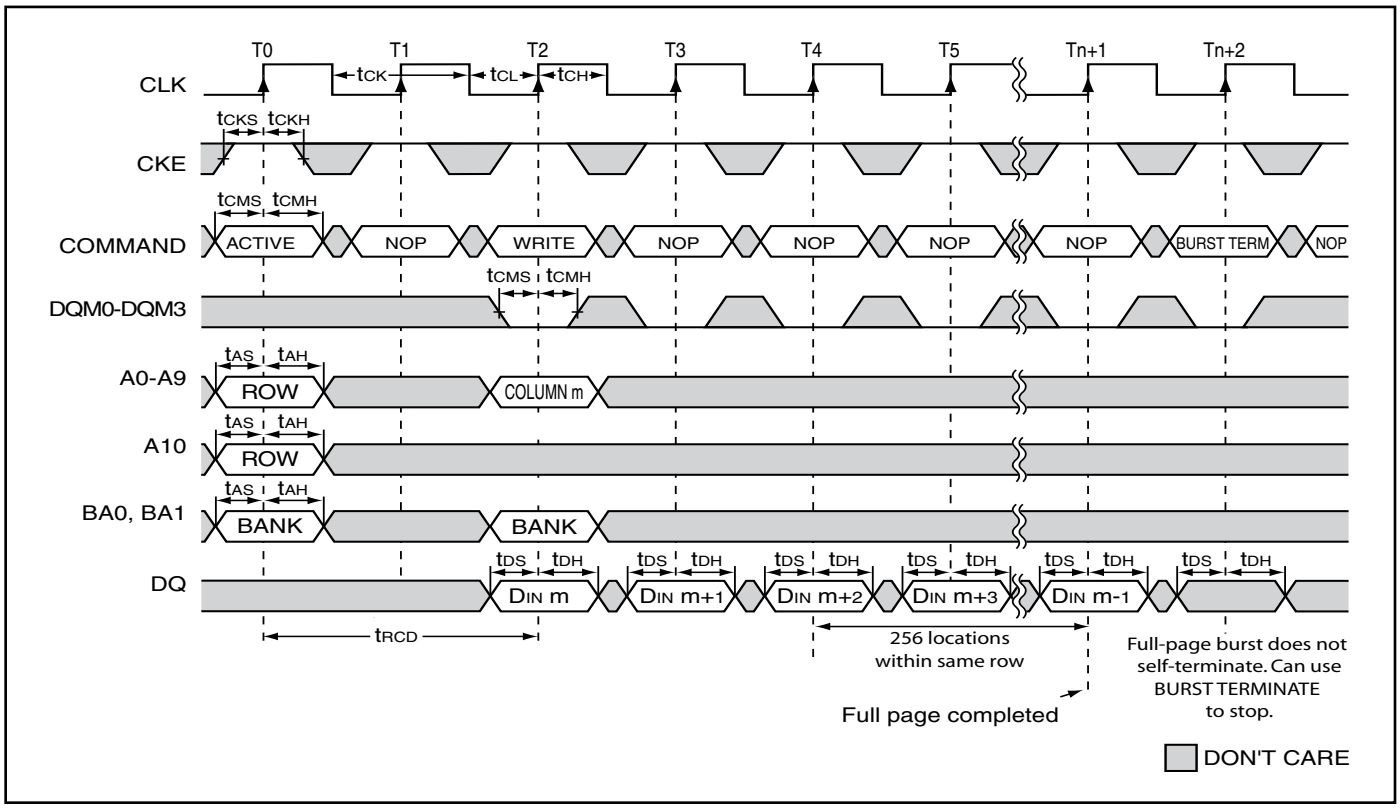
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ALTERNATING BANK WRITE ACCESS



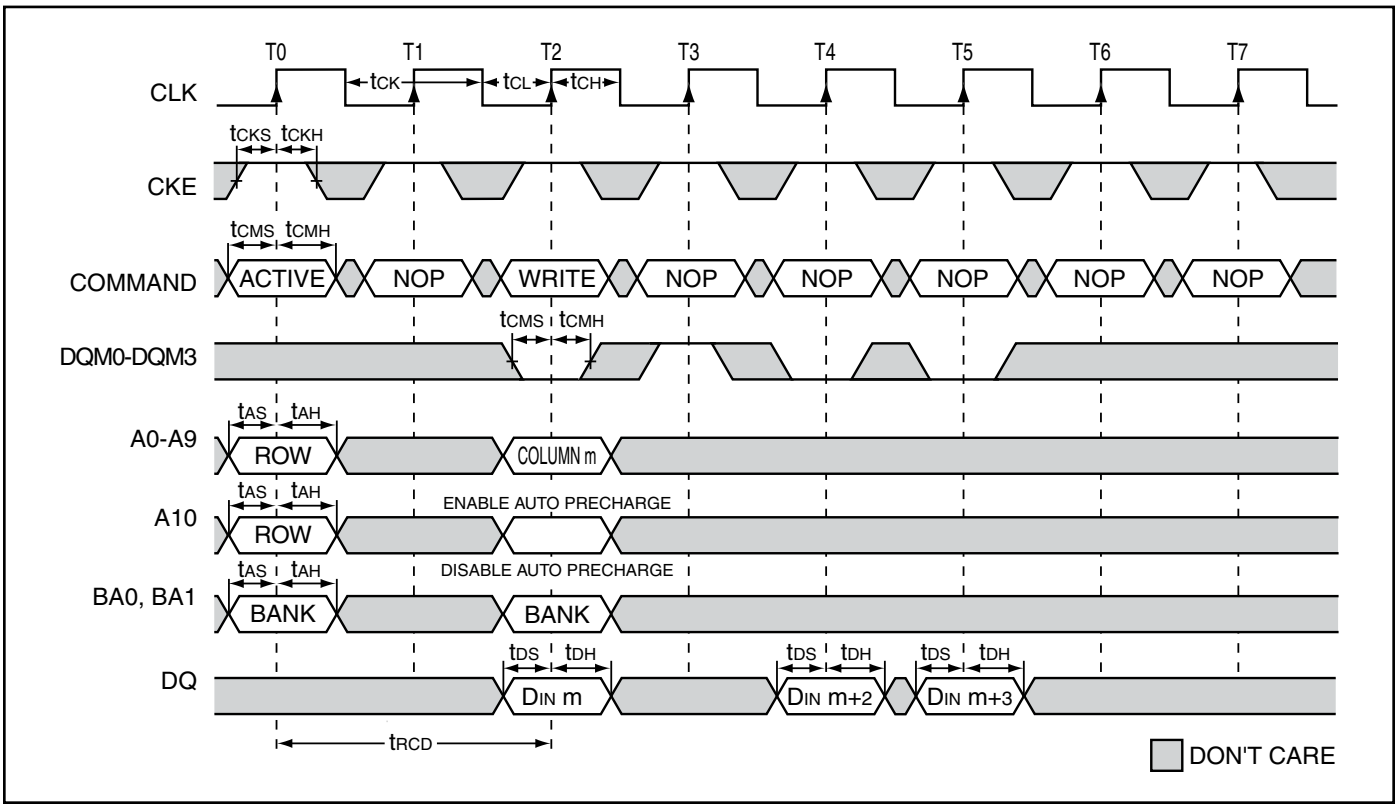
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WRITE - FULL PAGE BURST



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WRITE - DQM OPERATION



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ORDERING INFORMATION

Commercial Range: 0°C to +70°C

Frequency	Speed (ns)	Order Part No.	Package
200 MHz	5	IS42S32200L-5TL	400-mil TSOP II, Lead-free
		IS42S32200L-5BL	90-ball BGA, Lead-free
166 MHz	6	IS42S32200L-6TL	400-mil TSOP II, Lead free
		IS42S32200L-6BL	90-ball BGA, Lead-free
143 MHz	7	IS42S32200L-7TL	400-mil TSOP II, Lead free
		IS42S32200L-7BL	90-ball BGA, Lead-free

Industrial Range: -40°C to +85°C

Frequency	Speed (ns)	Order Part No.	Package
166 MHz	6	IS42S32200L-6TLI	400-mil TSOP II, Lead free
		IS42S32200L-6BLI	90-ball BGA, Lead-free
		IS42S32200L-6BI	90-ball BGA, Leaded
143 MHz	7	IS42S32200L-7TLI	400-mil TSOP II, Lead free
		IS42S32200L-7BLI	90-ball BGA, Lead-free

ORDERING INFORMATION

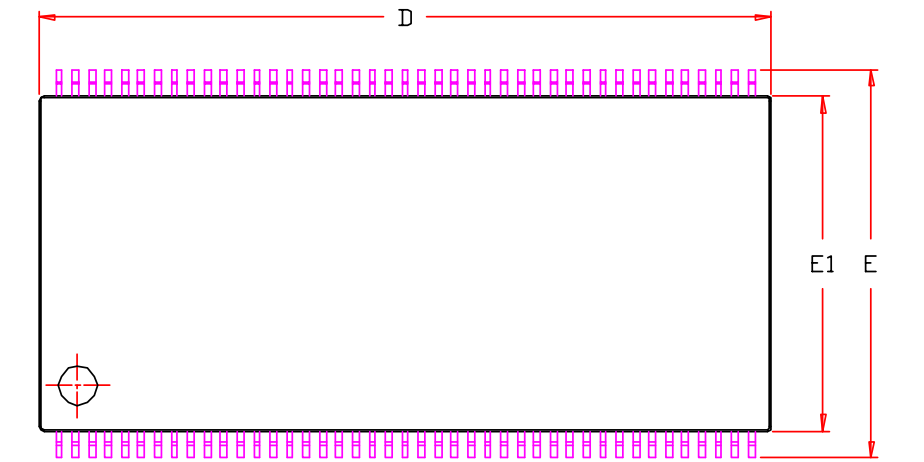
Automotive Range (A1): -40°C to +85°C

Frequency	Speed (ns)	Order Part No.	Package
166 MHz	6	IS45S32200L-6TLA1	400-mil TSOP II, Lead free
		IS45S32200L-6BLA1	90-ball BGA, Lead-free
143 MHz	7	IS45S32200L-7TLA1	400-mil TSOP II, Lead free
		IS45S32200L-7BLA1	90-ball BGA, Lead-free
		IS45S32200L-7BA1	90-ball BGA, Leaded

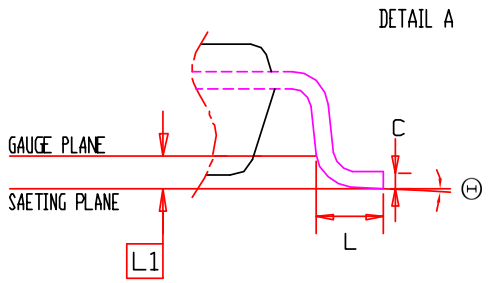
Automotive Range (A2): -40°C to +105°C

Frequency	Speed (ns)	Order Part No.	Package
166 MHz	6	IS45S32200L-6TLA2	400-mil TSOP II, Lead free
		IS45S32200L-6BLA2	90-ball BGA, Lead-free
143 MHz	7	IS45S32200L-7TLA2	400-mil TSOP II, Lead free
		IS45S32200L-7BLA2	90-ball BGA, Lead-free

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SYMBOL	DIMENSION IN MM		
	MIN.	NOM.	MAX.
A			1.20
A1	0.05		0.20
A2	0.95	1.00	1.05
b	0.17		0.27
C	0.12		0.21
D	22.02	22.22	22.42
E	11.56	11.76	11.96
E1	10.03	10.16	10.29
e	0.50 BSC.		
L	0.40	0.50	0.60
L1	0.25 BSC.		
ZD	0.61 REF.		
θ	0		8°



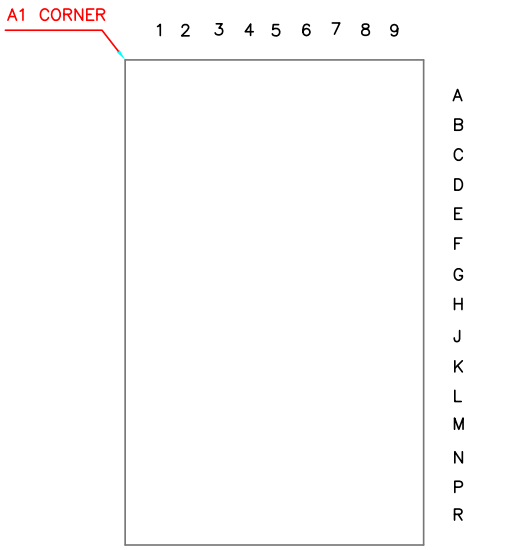
NOTE :

1. Controlling dimension : mm
2. Dimension D and E1 do not include mold protrusion .
3. Dimension b does not include dambar protrusion/intrusion.
4. Formed leads shall be planar with respect to one another within 0.1mm at the seating plane after final test.

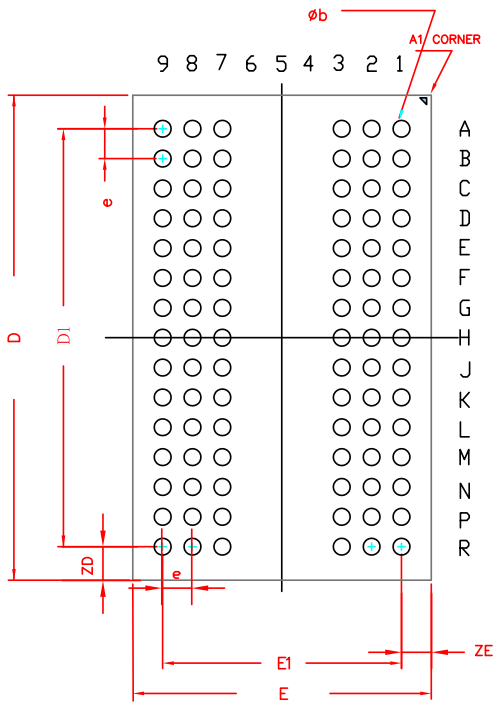
ISSI®	TITLE	86L 400mil TSOP-2 Package Outline	REV.	E	DATE	09/26/2006

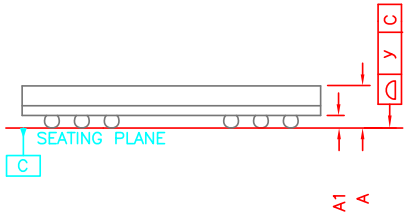
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TOP VIEW



BOTTOM VIEW





SYMBOL	DIMENSION IN MM			DIMENSION IN INCH		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A			1.20			0.047
A1	0.25		0.40	0.010		0.016
øb	0.40	0.45	0.50	0.016	0.018	0.020
D	12.90	13.00	13.10	0.508	0.512	0.516
D1	11.20 BSC.			0.441 BSC.		
E	7.90	8.00	8.10	0.311	0.315	0.319
E1	6.40 BSC.			0.252 BSC.		
e	0.80 BSC.			0.031 BSC.		
ZD	0.9 REF.			0.035 REF.		
ZE	0.8 REF.			0.032 REF.		
y	0.10			0.004		

NOTE :

1. CONTROLLING DIMENSION : MM .
2. Reference document : JEDEC MO-207

Ball Pitch :	Ball Diameter :
0.80	0.45

	TITLE	90L 8x13mm TF-BGA Package Outline	REV.	C	DATE	11/24/2014

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